## 24-Bit General Purpose Digital Signal Processor

The DSP56001 is a member of Motorola's family of HCMOS, low-power, general purpose Digital Signal Processors. The DSP56001 features 512 words of full speed, on-chip program RAM (PRAM) memory, two 256 word data RAMs, two preprogrammed data ROMs, and special on-chip bootstrap hardware to permit convenient loading of user programs into the program RAM. It is an off-the-shelf part since the program memory is user programmable. The core of the processor consists of three execution units operating in parallel — the data ALU, the address generation unit, and the program controller. The DSP56001 has MCU-style on-chip peripherals, program and data memory, as well as a memory expansion port. The MPU-style programming model and instruction set make writing efficient, compact code, straightforward.
The high throughput of the DSP56001 makes it well-suited for communication, high-speed control, numeric processing, computer and audio applications. The key features which facilitate this throughput are:

## - Speed

- Precision
- Parallelism
- Integration
- Invisible Pipeline
- Instruction Set
- DSP56000/DSP56001 Compatibility


## - Low Power

At 16.5 million instructions per second (MIPS) with a 33 MHz clock, the DSP56001 can execute a 1024 point complex Fast Fourier Transform in 1.98 milliseconds ( 66,240 clock cycles).
The data paths are 24 bits wide thereby providing 144 dB of dynamic range; intermediate results held in the 56-bit accumulators can range over 336 dB .
The data ALU, address arithmetic units, and program controller operate in parallel so that an instruction prefetch, a $24 \times 24$-bit multiplication, a 56 -bit addition, two data moves, and two address pointer updates using one of three types of arithmetic (linear, modulo, or reverse carry) can be executed in a single instruction cycle. This parallelism allows a four coefficient Infinite Impulse Response (IIR) filter section to be executed in only four cycles, the theoretical minimum for a single multiplier architecture.
In addition to the three independent execution units, the DSP56001 has six on-chip memories, three on-chip MCU style peripherals (Serial Communication Interface, Synchronous Serial Interface, and Host Interface), a clock generator and seven buses (three address and four data), making the overall system functionally complete and powerful, but also very low cost, low power, and compact.
The three-stage instruction pipeline is essentially invisible to the programmer thus allowing straightforward program development in either assembly language or a high-level language such as ANSI C.
The 62 instruction mnemonics are MCU-like making the transition from programming microprocessors to programming the DSP56001 digital signal processor as easy as possible. The orthogonal syntax supports control of the parallel execution units. This syntax provides $12,808,830$ different instruction variations using the 62 instruction mnemonics. The no-overhead DO instruction and the REPEAT (REP) instruction make writing straight-line code obsolete.
The DSP56001 is identical to the DSP56000 except that it has $512 \times 24$-bits of on-chip program RAM instead of 3.75 K of program ROM; a $32 \times 24$-bit bootstrap ROM for loading the program RAM from either a byte-wide memory mapped ROM or via the Host Interface; and the on-chip $X$ and $Y$ Data ROMs have been preprogrammed as positive Mu- and A-Law to linear expansion tables and a full, four quadrant sine wave table, respectively.
As a CMOS part, the DSP56001 is inherently very low power; however, three other features can reduce power consumption to an exceptionally low level.

- The WAIT instruction shuts off the clock in the central processor portion of the DSP56001.
- The STOP instruction halts the internal oscillator.
- Power increases linearly (approximately) with frequency; thus, reducing the clock frequency reduces power consumption.

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Figure 1. DSP56001 Block Diagram

In the USA:
For technical assistance call:
DSP Applications Helpline (512) 891-3230
For availability and literature call your local Freescale Sales Office or Authorized Freescale Distributor.
For free application software and information call the Dr. BuB electronic bulletin board:
9600/4800/2400/1200/300 baud
(512) 891-3771
(8 data bits, no parity, 1 stop)
In Europe, Japan and Asia Pacific
Contact your regional sales office or Freescale distributor.

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## SIGNAL DESCRIPTION

The DSP56001 is available in 132 pin surface mount (CQFP and PQFP) or an 88-pin pin-grid array packaging. Its input and output signals are organized into seven functional groups which are listed below and shown in Figure 1.

Port A Address and Data Buses
Port A Bus Control
Interrupt and Mode Control
Power and Clock
Host Interface or Port B I/O
Serial Communications Interface or Port C I/O
Synchronous Serial Interface or Port C I/O

## PORT A ADDRESS AND DATA BUS

## Address Bus (A0-A15)

These three-state output pins specify the address for external program and data memory accesses. To minimize power dissipation, A0-A15 do not change state when external memory spaces are not being accessed.

Data Bus (D0-D23)
These pins provide the bidirectional data bus for external program and data memory accesses. D0-D23 are in the high-impedance state when the bus grant signal is asserted.

## PORT A BUS CONTROL

## Program Memory Select ( $\overline{\mathrm{PS}}$ )

This three-state output is asserted only when external program memory is referenced. This pin is three-stated during RESET.

## Data Memory Select ( $\overline{\mathbf{D S}}$ )

This three-state output is asserted only when external data memory is referenced. This pin is three-stated during $\overline{\text { RESET. }}$

## X/Y Select (X/Y)

This three-state output selects which external data memory space ( X or Y ) is referenced by data memory select $(\overline{\mathrm{DS}})$. This pin is three-stated during RESET.


## Read Enable (RD)

This three-state output is asserted to read external memory on the data bus D0-D23. This pin is three-stated during RESET.

## Write Enable (WR)

This three-state output is asserted to write external memory on the data bus D0-D23. This pin is three-stated during RESET.

## Bus Request ( $\overline{\mathrm{BR}} / \overline{\mathrm{WT}}$ )

The bus request input $\overline{\mathrm{BR}}$ allows another device such as a processor or DMA controller to become the master of external data bus D0-D23 and external address bus A0-A15. When operating mode register (OMR) bit 7 is clear and $\overline{B R}$ is asserted, the DSP56001 will always release the external data bus D0-D23, address bus A0-A15, and bus control pins $\overline{\mathrm{PS}}, \overline{\mathrm{DS}}, \mathrm{X} / \overline{\mathrm{Y}}, \overline{\mathrm{RD}}$, and $\overline{\mathrm{WR}}$ (i. e., Port A), by placing these pins in the high-impedance state after execution of the current instruction has been completed. The BR pin should be pulled up when not in use.

If OMR bit 7 is set, this pin is an input that allows an external device to force wait states during an external Port A operation for as long as $\overline{\mathrm{WT}}$ is asserted.

## Bus Grant ( $\overline{\mathrm{BG}} / \overline{\mathrm{BS}}$ )

If OMR bit 7 is clear, this output is asserted to acknowledge an external bus request after Port $A$ has been released. If OMR bit 7 is set, this pin is bus strobe and is asserted when the DSP accesses Port A. This pin is three-stated during RESET.

## INTERRUPT AND MODE CONTROL

## Mode Select A/External Interrupt Request A (MODA/IRQA), Mode Select B/External Interrupt Request B (MODB/IRQB)

These two inputs have dual functions: 1) to select the initial chip operating mode and 2) to receive an interrupt request from an external source. MODA and MODB are read and internally latched in the DSP when the processor exits the RESET state. Therefore these two pins should be forced into the proper state during reset. After leaving the RESET state, the MODA and MODB pins automatically change to external interrupt requests $\overline{\mathrm{IRQA}}$ and $\overline{\mathrm{IRQB}}$. After leaving the reset state the chip operating mode can be changed by software. $\overline{\mathrm{IRQA}}$ and $\overline{\mathrm{IRQB}}$ may be programmed to be level sensitive or negative edge triggered. When edge triggered, triggering occurs at a voltage level and is not directly related to the fall time of the interrupt signal, however, the probability of noise on IRQA or $\overline{\text { IRQB }}$ generating multiple interrupts increases with increasing fall time of the interrupt signal. These pins are inputs during RESET.

## Reset (RESET)

This Schmitt trigger input pin is used to reset the DSP56001. When RESET is asserted, the DSP56001 is initialized and placed in the reset state. When the RESET signal is deasserted, the initial chip operating mode is latched from the MODA and MODB pins. When coming out of reset, deassertion occurs at a voltage level and is not directly related to the rise time of the reset signal; however, the probability of noise on $\overline{\text { RESET }}$ generating multiple resets increases with increasing rise time of the reset signal.

## POWER AND CLOCK

## Power (Vcc), Ground (GND)

There are five sets of power and ground pins used for the four groups of logic on the chip, two pairs for internal logic, one power and two ground for Port A address and control pins, one power and two ground for Port A data pins, and one pair for peripherals. Refer to the pin assignments in the LAYOUT PRACTICES section.

Figure 2. Functional Signal Groups
DSP56001

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## External Clock/Crystal Input (EXTAL)

EXTAL may be used to interface the crystal oscillator input to an external crystal or an external clock.

## Crystal Output (XTAL)

This output connects the internal crystal oscillator output to an external crystal. If an external clock is used, XTAL should not be connected.

## HOST INTERFACE

## Host Data Bus (H0-H7)

This bidirectional data bus is used to transfer data between the host processor and the DSP56001. This bus is an input unless enabled by a host processor read. $\mathrm{H} 0-\mathrm{H} 7$ may be programmed as general purpose parallel I/O pins called PB0-PB7 when the Host Interface is not being used. These pins are configured as a GPIO input pins during hardware reset.

## Host Address (HAO-HA2)

These inputs provide the address selection for each Host Interface register. HAO-HA2 may be programmed as general purpose parallel I/O pins called PB8-PB10 when the Host Interface is not being used. These pins are configured as a GPIO input pins during hardware reset.

## Host Read/Write (HR/W)

This input selects the direction of data transfer for each host processor access. HR/W may be programmed as a general purpose I/O pin called PB11 when the Host Interface is not being used. This pin is configured as a GPIO input pins during hardware reset.

## Host Enable (HEN)

This input enables a data transfer on the host data bus. When $\overline{\text { HEN }}$ is asserted and HR/W is high, $\mathrm{H} 0-\mathrm{H} 7$ become outputs, and DSP56001 data may be read by the host processor, When HEN is asserted and $\mathrm{HR} / \overline{\mathrm{W}}$ is low, $\mathrm{H} 0-\mathrm{H} 7$ become inputs and host data is latched inside the DSP when HEN is deasserted. Normally a chip select signal, derived from host address decoding and an enable clock, is used to generate $\overline{H E N}$. HEN may be programmed as a general purpose I/O pin called PB12 when the Host Interface is not being used. This pin is configured as a GPIO input pins during hardware reset.

## Host Request (HREQ)

This open-drain output signal is used by the DSP56001 Host Interface to request service from the host processor, DMA controller, or simple external controller. HREQ may be programmed as a general purpose I/O pin (not open-drain) called PB13 when the Host interface is not being used. HREQ should be pulled high when not in use. This pin is configured as a GPIO input pins during hardware reset.

## Host Acknowledge (HACK)

This input has two functions: 1) to receive a Host Acknowledge handshake signal for DMA transfers and, 2) to receive a Host Interrupt Acknowledge compatible with MC68000 Family processors. HACK may be programmed as a general purpose I/O pin called PB14 when the Host Interface is not being used. This pin is configured as a GPIO input pins during hardware reset. HACK should be pulled high when not in use.

## SERIAL COMMUNICATIONS INTERFACE (SCI)

## Receive Data (RXD)

This input receives byte-oriented data into the SCI Receive Shift Register. Input data is sampled on the positive edge of the Receive Clock. RXD may be programmed as a general purpose I/O pin called PCO when the SCI is not being used. This pin is configured as a GPIO input pins during hardware reset.

## Transmit Data (TXD)

This output transmits serial data from the SCI Transmit Shift Register. Data changes on the negative edge of the transmit clock. This output is stable on the positive edge of the transmit clock. TXD may be programmed as a general purpose I/O pin called PC1 when the SCI is not being used. This pin is configured as a GPIO input pins during hardware reset.

## SCI Serial Clock (SCLK)

This bidirectional pin provides an input or output clock from which the transmit and/or receive baud rate is derived in the asynchronous mode and from which data is transferred in the synchronous mode. SCLK may be programmed as a general purpose I/O pin called PC2 when the SCI is not being used. This pin is configured as a GPIO input pins during hardware reset.

## SYNCHRONOUS SERIAL INTERFACE (SSI)

## Serial Control Zero (SCO)

This bidirectional pin is used for control by the SSI. SC0 may be programmed as a general purpose I/O pin called PC3 when the SSI is not being used. This pin is configured as a GPIO input pins during hardware reset.

## Serial Control One (SC1)

This bidirectional pin is used for control by the SSI. SC1 may be programmed as a general purpose I/O pin called PC4 when the SSI is not being used. This pin is configured as a GPIO input pins during hardware reset.

## Serial Control Two (SC2)

This bidirectional pin is used for control by the SSI. SC2 may be programmed as a general purpose I/O pin called PC5 when the SSI is not being used. This pin is configured as a GPIO input pins during hardware reset.

## SSI Serial Clock (SCK)

This bidirectional pin provides the serial bit rate clock for the SSI when only one clock is used. SCK may be programmed as a general purpose I/O pin called PC6 when the SSI is not being used. This pin is configured as a GPIO input pins during hardware reset.

## SSI Receive Data (SRD)

This input pin receives serial data into the SSI Receive Shift Register. SRD may be programmed as a general purpose I/O pin called PC7 when the SSI is not being used. This pin is configured as a GPIO input pins during hardware reset.

## SSI Transmit Data (STD)

This output pin transmits serial data from the SSI Transmit Shift Register. STD may be programmed as a general purpose I/O pin called PC8 when the SSI is not being used. This pin is configured as a GPIO input pins during hardware reset.

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## DSP56001 Electrical Characteristics <br> Electrical Specifications

The DSP is fabricated in high density CMOS with TTL compatible inputs and outputs.

Maximum Ratings ( $\mathrm{V}_{\mathrm{SS}}=\mathbf{0} \mathrm{Vdc}$ )

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Supply Voltage | Vcc | -0.3 to +7.0 | V |
| All Input Voltages | Vin | $\mathrm{V}_{\text {ss }}-0.5$ to $\mathrm{Vcc}+0.5$ | V |
| Current Drain per Pin excluding Vcc and $\mathrm{V}_{\mathrm{SS}}$ | I | 10 | mA |
| Operating Temperature Range | TJ | -40 to +105 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | Tstg | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Maximum Electrical Ratings

Thermal Characteristics - PGA Package

| Characteristics <br> Thermal Resistance - Ceramic | Symbol | Value | Rating |
| :--- | :---: | :---: | :---: |
| Junction to Ambient | $\Theta_{\mathrm{JA}}$ | 27 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Junction to Case (estimated) | $\Theta_{\mathrm{JC}}$ | 6.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Thermal Characteristics - CQFP Package

| Characteristics <br> Thermal Resistance - Ceramic | Symbol | Value | Rating |
| :--- | :---: | :---: | :---: |
| Junction to Ambient | $\Theta_{\mathrm{JA}}$ | 40 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Junction to Case (estimated) | $\Theta_{\mathrm{JC}}$ | 7.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Thermal Characteristics - PQFP Package

| Characteristics <br> Thermal Resistance - Plastic | Symbol | Value | Rating |
| :--- | :---: | :---: | :---: |
| Junction to Ambient | $\Theta_{\mathrm{JA}}$ | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Junction to Case (estimated) | $\Theta_{\mathrm{JC}}$ | 13.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

This device contains circuitry protecting against damage due to high static voltage or electrical fields; however, it is advised that normal precautions be taken to avoid application of any voltages higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either Gnd or Vcc).

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## DSP56001 Electrical Characteristics

## Power Considerations

The average chip-junction temperature, $\mathrm{T}_{\mathrm{J}}$, in ${ }^{\circ} \mathrm{C}$ can be obtained from:

$$
\begin{equation*}
\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\mathrm{A}}+\left(\mathrm{P}_{\mathrm{D}} \times \Theta_{\mathrm{JA}}\right) \tag{1}
\end{equation*}
$$

Where:
$\mathrm{T}_{\mathrm{A}}=$ Ambient Temperature, ${ }^{\circ} \mathrm{C}$
$\Theta_{\mathrm{JA}}=$ Package Thermal Resistance, Junction-to-Ambient, ${ }^{\circ} \mathrm{C} / \mathrm{W}$
$P_{D}=P_{\text {INT }}+P_{I / Q}$
$P_{\text {INT }}=I_{C C} \times V c c$, Watts - Chip Internal Power
$\mathrm{P}_{\mathrm{l} / \mathrm{O}}=$ Power Dissipation on Input and Output Pins - User Determined
For most applications $\mathrm{P}_{\mathrm{I} / \mathrm{O}} \ll \mathrm{P}_{\mathrm{INT}}$ and can be neglected; however, $\mathrm{P}_{\mathrm{I} / \mathrm{O}}+\mathrm{P}_{\mathrm{INT}}$ must not exceed $\mathrm{P}_{\mathrm{d}}$. An appropriate relationship between $P_{D}$ and $T_{J}$ (if $P_{I / O}$ is neglected) is:

$$
\begin{equation*}
P_{D}=K /\left(T_{J}+273^{\circ} \mathrm{C}\right) \tag{2}
\end{equation*}
$$

Solving equations (1) and (2) for $K$ gives:

$$
\begin{equation*}
\mathrm{K}=\mathrm{P}_{\mathrm{D}} \times\left(\mathrm{T}_{\mathrm{A}}+273^{\circ} \mathrm{C}\right)+\Theta_{\mathrm{JA}} \times \mathrm{P}_{\mathrm{D}}^{2} \tag{3}
\end{equation*}
$$

Where K is a constant pertaining to the particular part. K can be determined from equation (2) by measuring $\mathrm{P}_{\mathrm{D}}$ (at equilibrium) for a known $T_{A}$. Using this value of $K$, the values of $P_{D}$ and $T_{J}$ can be obtained by solving equations (1) and (2) iteratively for any value of $T_{A}$. The total thermal resistance of a package ( $\Theta_{J A}$ ) can be separated into two components, $\Theta_{J C}$ and $C_{A}$, representing the barrier to heat flow from the semiconductor junction to the package (case) surface ( $\Theta_{\mathrm{JC}}$ ) and from the case to the outside ambient ( $\mathrm{C}_{\mathrm{A}}$ ). These terms are related by the equation:

$$
\begin{equation*}
\Theta_{\mathrm{JA}}=\Theta_{\mathrm{JC}}+\mathrm{C}_{\mathrm{A}} \tag{4}
\end{equation*}
$$

$\Theta_{\mathrm{JC}}$ is device related and cannot be influenced by the user. However, $\mathrm{C}_{\mathrm{A}}$ is user dependent and can be minimized by such thermal management techniques as heat sinks, ambient air cooling, and thermal convection. Thus, good thermal management on the part of the user can significantly reduce $\mathrm{C}_{\mathrm{A}}$ so that $\Theta_{\mathrm{JA}}$ approximately equals $\Theta_{\mathrm{JC}}$. Substitution of $\Theta_{\mathrm{JC}}$ for $\Theta_{\mathrm{JA}}$ in equation (1) will result in a lower semiconductor junction temperature. Values for thermal resistance presented in this document, unless estimated, were derived using the procedure described in Freescale Reliability Report 7843, "Thermal Resistance Measurement Method for MC68XX Microcomponent Devices", and are provided for design purposes only. Thermal measurements are complex and dependent on procedure and setup. User-derived values for thermal resistance may differ.

## Layout Practices

Each Vcc pin on the DSP56001 should be provided with a low-impedance path to +5 volts. Each GND pin should likewise be provided with a low-impedance path to ground. The power supply pins drive four distinct groups of logic on chip. They are:

| Vcc | GND | Function |
| :--- | :--- | :--- |
| G12,C6 | G11,B7 | Internal Logic supply pins |
| L8 | L6,L9 | Address bus output buffer supply pins |
| G3 | D3,J3 | Data bus output buffer supply pins |
| C9 | E11 | Port B and C output buffer supply pins |

Power and Ground Connections for PGA

| Vcc | GND | Function |
| :--- | :--- | :--- |
| $35,36,128,129$ | $33,34,130,131$ | Internal Logic supply pins |
| 63,64 | $55,56,73,74$ | Address bus output buffer supply pins |
| 100,101 | $90,91,111,112$ | Data bus output buffer supply pins |
| 12,13 | 23,24 | Port B and C output buffer supply pins |

Power and Ground Connections for CQFP and PQFP

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## DSP56001 Electrical Characteristics

## Power and Ground Connections

The Vcc power supply should be bypassed to ground using at least four 0.1 uF by-pass capacitors located either underneath the chip or as close as possible to the four sides of the package. The capacitor leads and associated printed circuit traces connecting to chip Vcc and Gnd should be kept to less than $1 / 2$ " per capacitor lead. A four-layer board is recommended, employing two inner layers as Vcc and Gnd planes. All output pins on the DSP56001 have fast rise and fall times - typically less than 3 ns . with a 10 pf. load. Printed circuit (PC) trace interconnection length should be minimized in order to minimize undershoot and reflections caused by these fast output switching times. This recommendation particularly applies to the address and data buses as well as the $\overline{\mathrm{RD}}, \overline{\mathrm{WR}, \overline{\mathrm{IRQA}}, \mathrm{IRQB},}$ and $\overline{\mathrm{HEN}}$ pins. Maximum PC trace lengths on the order of 6 " are recommended. Capacitance calculations should consider all device loads as well as parasitic capacitances due to the PC traces. Attention to proper PCB layout and bypassing becomes especially critical in systems with higher capacitive loads because these loads create higher transient currents in the Vcc and GND circuits. Pull up/down all unused inputs or signals that will be inputs during reset.

## Signal Stability

When designing hardware to interface with the Host Interface, it is important to ensure that all signals be clean and free from noise. Particular attention should be given to the quality of the Host Enable ( $\overline{\mathrm{HEN}}$ ). All inputs to the port should be stable when $\overline{\mathrm{HEN}}$ is asserted and should remain stable until $\overline{\mathrm{HEN}}$ has fully returned to the deasserted state. It is important to note that such phenomena as ground-bounce and cross-talk can inadvertently cause $\overline{\mathrm{HEN}}$ to temporarily rise above $\mathrm{V}_{\mathrm{il}}$ max. Should this occur without completing the full logic transition to $\mathrm{V}_{\text {ih min }}$, the DSP56001 Host Port may not correctly update the port status information which can result in storing two or more copies of a single down loaded data word. Of course, if a full logic transition occurs, the part will complete a normal data transfer operation.

## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics

DC Electrical Characteristics ( $\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 10 \% ; \mathrm{T}_{\mathrm{J}}=-40$ to $+105^{\circ} \mathrm{C}$ at 20.5 MHz and 27 MHz )
$\left(\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 5 \% ; \mathrm{T}_{\mathrm{J}}=-40\right.$ to $+105^{\circ} \mathrm{C}$ at 33 MHz )

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltagea <br>  <br> $20,27 \mathrm{MHz}$ <br> 3 MHz | Vcc | $\begin{gathered} 4.5 \\ 4.75 \end{gathered}$ | 5.0 | $\begin{aligned} & 5.5 \\ & 5.25 \end{aligned}$ | V |
| Input High Voltage <br> Except EXTAL, $\overline{R E S E T}$, MODA/ $\overline{\mathrm{RQA}}, \mathrm{MODB} / \overline{\mathrm{RQB}}$ | $\mathrm{V}_{\mathrm{IH}}$ | 2.0 | - | Vcc | V |
| Input Low Voltage Except EXTAL, MODA//RQA, MODB//RQB | $\mathrm{V}_{\text {IL }}$ | -0.5 | - | 0.8 | V |
| Input High Voltage EXTAL | $\mathrm{V}_{\mathrm{IHC}}$ | 4.0 | - | Vcc | V |
| Input Low Voltage EXTAL | VILC | -0.5 | - | 0.6 | V |
| Input High Voltage $\overline{\text { RESET }}$ | $\mathrm{V}_{\text {IHR }}$ | 2.5 | - | Vcc | V |
| Input High Voltage MODA/\RQA and MODB/IRQB | $\mathrm{V}_{\text {IHM }}$ | 3.5 | - | Vcc | V |
| Input Low Voltage MODA/ $\overline{\text { RQA }}$ and MODB/IRQB | $\mathrm{V}_{\text {ILM }}$ | -0.5 | - | 2.0 | V |
| Input Leakage Current EXTAL, RESET, MODA//RQA, MODB//RQB, $\overline{B R}$ | $\mathrm{I}_{\text {in }}$ | -1 | - | 1 | uA |
| Three-State (Off-State) Input Current (@2.4 V/0.4 V) | $\mathrm{I}_{\text {TSI }}$ | -10 | - | 10 | uA |
| Output High Voltage $\quad\left(\mathrm{l}_{\mathrm{OH}}=-0.4 \mathrm{~mA}\right)$ | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | - | V |
| Output Low Voltage $\text { ( } \mathrm{bL}=1.6 \mathrm{~mA} \text {; }$ <br> $\overline{\mathrm{RD}}, \overline{\mathrm{WR}} \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$; Open Drain HREQ $\left.\mathrm{I}_{\mathrm{OL}}=6.7 \mathrm{~mA}, \mathrm{TXD} \operatorname{IOL}=6.7 \mathrm{~mA}\right)$ | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.4 | V |
| Total Supply Current $5.25 \mathrm{~V}, 33 \mathrm{MHz}$ <br>  $5.5 \mathrm{~V}, 27 \mathrm{MHz}$ <br>  $5.5 \mathrm{~V}, 20 \mathrm{MHz}$ <br>  in WAIT Mode (see Note 1) <br>  in STOP Mode (see Note 1) | IDD33 <br> IDD27 <br> IDD20 <br> IDDW <br> $\mathrm{I}_{\mathrm{DDS}}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $\begin{aligned} & 160 \\ & 130 \\ & 100 \\ & 10 \\ & 100 \end{aligned}$ | $\begin{aligned} & 185 \\ & 155 \\ & 115 \\ & 25 \\ & 2000 \end{aligned}$ | mA <br> mA <br> mA <br> mA <br> $\mu \mathrm{A}$ |
| Input Capacitance (see Note 2) | Cin | - | 10 | - | pf |

Notes:

1. In order to obtain these results all inputs must be terminated (i.e., not allowed to float).
2. Periodically sampled and not $100 \%$ tested.

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## DSP56001 Electrical Characteristics

## AC Electrical Characteristics

The timing waveforms in the AC Electrical Characteristics are tested with a $\mathrm{V}_{\mathrm{IL}}$ maximum of 0.5 V and a $\mathrm{V}_{\mathrm{IH}}$ minimum of 2.4 V for
 Characteristics. AC timing specifications which are referenced to a device input signal are measured in production with respect to the $50 \%$ point of the respective input signal's transition. DSP56001 output levels are measured with the production test machine $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ reference levels set at 0.8 V and 2.0 V respectively.

## AC Electrical Characteristics - Clock Operation

The DSP56001 system clock may be derived from the on-chip crystal oscillator as shown in Clock Figure 1, or it may be externally supplied. An externally supplied square wave voltage source should be connected to EXTAL, leaving XTAL physically unconnected (see Clock Figure 2) to the board or socket. The rise and fall time of this external clock should be 5 ns maximum.

| Num | Characteristics | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
|  | Frequency of Operation (EXTAL Pin) | 4.0 | 20.5 | 4.0 | 27.0 | 4.0 | 33.0 | MHz |
| 1 | External Clock Input High (tch) EXTAL Pin (see Note 1 and 2) | 22 | 150 | 17 | 150 | 13.5 | 150 | ns |
| 2 | External Clock Input Low (tcl) - <br> EXTAL Pin (see Note 1 and 2) | 22 | 150 | 17 | 150 | 13.5 | 150 | ns |
| 3 | Clock Cycle Time = cyc $=2 \mathrm{~T}$ | 48.75 | 250 | 37 | 250 | 30.33 | 250 | ns |
| 4 | Instruction Cycle Time $=$ Icyc $=4 \mathrm{~T}$ | 97.5 | 500 | 74 | 500 | 60 | 500 | ns |

Notes:

1. External Clock Input High and External Clock Input Low are measured at $50 \%$ of the input transition. tch and tcl are dependent on the duty cycle.
2. $\mathrm{T}=$ Icyc $/ 4$ is used in the electrical characteristics. T represents an average which is independent of the duty cycle.

## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics



Fundamental Frequency Crystal Oscillator

Suggested Component Values
For $\mathrm{f}_{\text {osc }}=\mathbf{4 M H z}$ :
$\mathrm{R}=680 \mathrm{~K} \Omega \pm 10 \%$
C $=20 \mathrm{pf} \pm 20 \%$
For $\mathrm{f}_{\text {osc }}=\mathbf{3 0} \mathbf{~ M H z : ~}$
$\mathrm{R}=680 \mathrm{~K} \Omega \pm 10 \%$
C $=20 \mathrm{pf} \pm 20 \%$

## Notes:

(1) The suggested crystal source is ICM, \# 433163-4.00 (4MHz fundamental, 20 pf load) or \# 436163-30.00 (30 MHz fundamental, 20 pf load).

$3^{\text {rd }}$ Overtone Crystal Oscillator

Suggested Component Values
$R 1=470 K \Omega \pm 10 \%$
$R 2=330 \Omega \pm 10 \%$
C1 $=0.1 \mu \mathrm{f} \pm 20 \%$
C2 $=26 \mathrm{pf} \pm 20 \%$
C3 $=20 \mathrm{pf} \pm 10 \%$
L1 $=2.37 \mu \mathrm{H} \pm 10 \%$
XTAL $=33 \mathrm{MHz}$, AT cut, 20 pf load, $50 \Omega$ max series resistance

Notes:
(1) $3^{\text {rd }}$ overtone crystal.
(2) The suggested crystal source is ICM, \# 471163-33.00 (33 $\mathrm{MHz} 3^{\text {rd }}$ overtone, 20 pf load).
(3) R2 limits crystal current
(4) Reference Benjamin Parzen, The Design of Crystal and

Other Harmonic Oscillators, John Wiley\& Sons, 1983

## Clock Figure 1. Crystal Oscillator Circuits

EXTAL


Note: The midpoint is $\mathrm{V}_{\mathrm{ILC}}+0.5\left(\mathrm{~V}_{\mathrm{IHC}}-\mathrm{V}_{\mathrm{ILC}}\right)$.

Clock Figure 2. External Clock Timing

## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics

AC Electrical Characteristics - Reset, Stop, Mode Select and Interrupt Timing

```
\(\left(\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 10 \%, \mathrm{~T}_{\mathrm{J}}=-40\right.\) to \(+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}\) Load at 20.5 MHz and 27 MHz )
(Vcc \(=5.0 \mathrm{Vdc} \pm 5 \%, \mathrm{~T}_{\mathrm{J}}=-40\) to \(+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}\) Load at 33 MHz )
(See Control Figure 1 through 8)
cyc \(=\) Clock cycle \(=1 / 2\) instruction cycle \(=2 \mathrm{~T}\) cycles
WS = Number of wait states (1 WS = 1 cyc = 2T) programmed into external bus access
using BCR (WS = 0-15)
tch \(=\) Clock high period
tcl = Clock low period
```

| Num | Characteristics | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 9 | Delay from RESET Assertion to Address High Impedance (periodically sampled and not $100 \%$ tested) | - | 50 | - | 38 | - | 31 | ns |
| 10 | Minimum Stabilization Duration Internal Osc. (see Note 1) External Clock (see Note 2) | $\begin{gathered} 75000_{\star} \text { сус } \\ 25_{\star} \text { сус } \end{gathered}$ | - | $\begin{gathered} 75000^{*} \text { cyc } \\ 25_{\star} \text { cyc } \end{gathered}$ | - | $\begin{gathered} 75000^{*} \text { cyc } \\ 25_{\star} \text { cyc } \end{gathered}$ | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 11 | Delay from Asynchronous RESET Deassertion to First External Address Output (Internal Reset Negation) | $8_{\star} \mathrm{cyc}$ | $9{ }_{*} \mathrm{cyc}+40$ | $8^{*} \mathrm{cyc}$ | 9*cyc+31 | 8*cyc | 9*cyc+25 | ns |
| 12 | Synchronous Reset Setup Time from RESET Deassertion to Falling Edge of External Clock | 20 | cyc-10 | 15 | cyc-8 | 13 | cyc-7 | ns |
| 13 | Synchronous Reset Delay Time from the Synchronous Falling Edge of External Clock to the First External Address Output | 8*cyc+5 | $8_{\star} \mathrm{cyc}+30$ | $8^{*} c y c+5$ | 8*cyc+23 | 8*cyc+5 | $8^{*} \mathrm{cyc}+19$ | ns |
| 14 | Mode Select Setup Time | 100 | - | 77 | - | 62 | - | ns |
| 15 | Mode Select Hold Time | 0 | - | 0 |  | 0 |  | ns |
| $\begin{gathered} 16 \\ 16 a \end{gathered}$ | Edge-Triggered Interrupt Request assertion deassertion | $\begin{aligned} & 25 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & 17 \\ & 10 \end{aligned}$ | - | $\begin{aligned} & 16 \\ & 10 \end{aligned}$ | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |



# Freescale Semiconductor, Inc. 

## DSP56001 Electrical Characteristics

## AC Electrical Characteristics - Reset, Stop, Mode Select, and Interrupt Timing (Continued)


#### Abstract

NOTE When using fast interrupts and $\overline{I R Q A}$ and $\overline{I R Q B}$ are defined as level-sensitive, then timings 19 through 22 apply to prevent multiple interrupt service. To avoid these timing restrictions, the negative edge-triggered mode is recommended when using fast interrupt. Long interrupts are recommended when using level-sensitive mode.


| Num | Characteristics | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 17 | Delay from $\overline{\mathrm{IRQA}, \overline{\mathrm{IRQB}}}$ Assertion to External Memory Access Address Out Valid Caused by First Interrupt Instruction Fetch Instruction Execution | $\begin{aligned} & 5 \times c y c+t c h \\ & 9_{*}^{*} \text { cyc }+ \text { tch } \end{aligned}$ | $-$ | $\begin{aligned} & 5_{*} \text { cyc+tch } \\ & 9_{*} \text { cyc+tch } \end{aligned}$ | - | $\begin{aligned} & 5_{\star} \text { cyc+tch } \\ & 9_{*} \text { cyc+tch } \end{aligned}$ | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 18 | Delay from $\overline{\mathrm{IRQA}}, \overline{\mathrm{IRQB}}$ Assertion to General Purpose Transfer Output Valid Caused by First Interrupt Instruction Execution | $\begin{gathered} \text { 11+cyc } \\ + \text { tch } \end{gathered}$ | - | $\begin{aligned} & \text { 11. cyc } \\ & \text { +tch } \end{aligned}$ | - | $\begin{aligned} & \text { 11×cyc } \\ & \text { +tch } \end{aligned}$ | - | ns |
| 19 | Delay from Address Output Valid Caused by First Interrupt Instruction Execution to Interrupt Request Deassertion for Level Sensitive Fast Interrupts | - | $\begin{gathered} 2_{\star}^{\text {cyc }+\mathrm{tcl}+} \\ \text { (cyc WS) } \\ -44 \end{gathered}$ | - | $\begin{array}{\|c} \hline \text { 2^cyc+tcl+ } \\ \text { (cyc.wS) } \\ -34 \end{array}$ | - | $\begin{array}{\|c} 2_{\star}^{\star} \text { cyc+tcl+ } \\ \text { (cyc.WS) } \\ -27 \end{array}$ | ns |
| 20 | Delay from RD Assertion to Interrupt Request Deassertion for Level Sensitive Fast Interrupts | - | $\begin{gathered} \text { 2_cyc+ }_{\star} \text { cy } \\ \left(\text { cyc }_{\star} \text { WS }\right) \\ -40 \end{gathered}$ | - | $\begin{gathered} 2_{\star} \text { cyc+ } \\ \left(\text { cyc }^{2} \text { WS }\right) \\ -31 \end{gathered}$ | - | $\begin{gathered} \hline 2_{\star} \text { cyc+ } \\ \text { (cyc WS) } \\ -25 \end{gathered}$ | ns |
| 21 | Delay from $\overline{W R}$ Assertion to WS $=0$ Interrupt Request Deassertion for WS>0 Level Sensitive Fast Interrupts | - | $\begin{gathered} \hline 2_{\star}^{\text {cyc }}-40 \\ \text { cyctclt+ } \\ \left(\mathrm{cyc}_{\star} \mathrm{WS}\right) \\ -40 \end{gathered}$ | - | $\begin{gathered} \hline \text { 2сyc-31 } \\ \text { cyc+tcl+ } \\ (\text { cyc } W S \text { ) } \\ -31 \end{gathered}$ | - | $\begin{gathered} \hline \text { 2сyc-25 } \\ \text { cyc+tcl+ } \\ \text { (cyc WS) } \\ -25 \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 22 | Delay from General-Purpose Output Valid to Interrupt Request Deassertion for Level Sensitive Fast Interrupts - If Second Interrupt Instruction is: Single Cycle Two Cycle | - | $\begin{gathered} \mathrm{tcl}-60 \\ \left(2_{\star} \mathrm{cyc}\right)+\mathrm{tcl} \\ -60 \end{gathered}$ | - | $\begin{gathered} \mathrm{tcl}-46 \\ \left(2_{\star} \mathrm{cyc}\right)+\mathrm{tcl} \\ -46 \end{gathered}$ | - | $\left\lvert\, \begin{gathered} \mathrm{tcl}-37 \\ (2 \mathrm{cyc})+\mathrm{tcl} \\ -37 \end{gathered}\right.$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |

## DSP56001 Electrical Characteristics

## AC Electrical Characteristics－Reset，Stop，Mode Select，and Interrupt Timing （Continued）

| Num | Characteristics | 20．5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 23 | Synchronous Interrupt Setup Time from IRQA，IRQB Assertion to the Synchronous Rising Edge of External Clock（see Notes 5，6） | 25 | cyc－10 | 19 | cyc－8 | 16 | cyc－7 | ns |
| 24 | Synchronous Interrupt Delay Time from the Synchronous Rising Edge of External Clock to the First External Address Output Valid Caused by the First Instruction Fetch after Coming out of Wait State（see Notes 3，5） | $\underset{\substack{13 \times c y c+\\ \text { tch }+8}}{ }$ | $\begin{aligned} & 13+\mathrm{cyc}+ \\ & \text { tch }+30 \end{aligned}$ | $\underset{\substack{13 \times c y c+\\ \text { tch }+6}}{ }$ | $\begin{gathered} 13 \times \text { cyct } \\ \text { tch }+23 \end{gathered}$ | $\underset{\substack{13 \times c y c+\\ \text { tch }+5}}{ }$ | $\begin{aligned} & 13 \times \mathrm{cyc}+ \\ & \text { tch }+19 \end{aligned}$ | ns |
| 25 | Duration for $\overline{\mathrm{RQ} A}$ Assertion to Recover from Stop State（see Note 4） | 25 | － | 19 | － | 16 | － | ns |
| 26 | Delay from IRQA Assertion to Fetch of First Instruction（for Stop）for Internal Osc／OMR bit $6=0$ External Clock $/$ OMR bit $6=1$ （see Notes 1，2，and 7） | $\begin{gathered} 65545_{\star} \text { сyc } \\ 17_{\star} \text { суc } \end{gathered}$ | 二 | $\begin{gathered} 65545 \text { \&yc } \\ 17 \star \text { сyc } \end{gathered}$ | 二 | $\begin{gathered} 65545_{\star} \text { cyc } \\ 17_{\star} \text { сyc } \end{gathered}$ | 二 | $\mathrm{ns}$ |
| 27 | Duration for Level Sensitive $\overline{\text { RQA }}$ Assertion to Fetch of First Interrupt Instruction（for Stop）for Internal Osc／OMR bit $6=0$ <br> External Clock／OMR bit $6=1$ （see Notes 1，2，and 7） | $\begin{gathered} 65533 \text { cyc } \\ +\mathrm{tcl} \\ 5_{\star} \mathrm{cyc}+\mathrm{tcl} \end{gathered}$ | $-$ | $\begin{gathered} 65533 \text { cyc } \\ + \text { tcl } \\ 5_{\star} \mathrm{cyc}+\mathrm{tcl} \end{gathered}$ | $-$ | $\begin{gathered} 65533 \text { cyc } \\ +\mathrm{tcl} \\ 5_{\star} \mathrm{cyc}+\mathrm{tcl} \end{gathered}$ | $-$ | ns ns |
| 28 | Delay from Level Sensitive IRQA Assertion to Fetch of First Interrupt Instruction（for Stop）for <br> Internal Osc／OMR bit $6=0$ <br> External Clock／OMR bit $6=1$ （see Notes 1，2，and 7） | $\begin{gathered} 65545_{\star} \text { cyc } \\ 17_{\star} \mathrm{cyc} \end{gathered}$ | 二 | $\begin{gathered} 65545_{\star} \text { cyc } \\ 17_{\star} \text { cyc } \end{gathered}$ | - | $\begin{array}{\|c} 65545_{\star} \text { cyc } \\ 17_{\star} \text { cyc } \end{array}$ | - | $\mathrm{ns}$ |

Notes：
1．A clock stabilization delay is required when using the on－chip crystal oscillator in two cases：
1）after power－on reset，and
2）when recovering from Stop mode．
During this stabilization period，T will not be constant．Since this stabilization period varies，a delay of $150,000 \mathrm{~T}$ is typically allowed to assure that the oscillator is stabilized before executing programs．While it is possible to set OMR bit $6=1$ when using the internal crystal oscillator，it is not recommended and these specifications do not guarantee timings for that case．See Section 8.5 in the DSP56000／DSP56001 User＇s Manual for additional information．
2．Circuit stabilization delay is required during reset when using an external clock in two cases：
1）after power－on reset，and
2）when recovering from Stop mode．
3．For Revision B silicon，the min and max numbers are $12 c y c+T c h+8$ and $12 c y c+T c h+30$ ，respec－ tively．
4．The minimum is specified for the duration of an edge triggered $\overline{\mathrm{IRQA}}$ interrupt required to recover from the STOP state without having the $\overline{\overline{R Q A}}$ interrupt accepted．
5．Timing \＃23 is for all IRQx interrupts while timing \＃24 is only when exiting WAIT．
6．Timing \＃23 triggers off T1 in the normal state and off T1／T3 when exiting the WAIT state．
7．The timings in the table are for Rev．C parts．The timings for Rev．C parts are shorter by 1 cyc than the Rev．B parts when OMR6＝0．

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## DSP56001 Electrical Characteristics



$\overline{\mathrm{IRQA}}, \overline{\mathrm{IRQB}}$


Control Figure 4. External Interrupt Timing (Negative Edge-Triggered)

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## DSP56001 Electrical Characteristics

Control Figure 6. Synchronous Interrupt and Synchronous Wait State Timing


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## DSP56001 Electrical Characteristics HOST PORT USAGE CONSIDERATIONS

Careful synchronization is required when reading multibit registers that are written by another asynchronous system. This is a common problem when two asynchronous systems are connected. The situation exists in the Host port. The considerations for proper operation are discussed below.

## Host Programmer Considerations

1. Unsynchronized Reading of Receive Byte Registers

When reading receive byte registers, RXH, RXM, or RXL, the Host programmer should use interrupts or poll the RXDF flag which indicates that data is available. This assures that the data in the receive byte registers will be stable.
2. Overwriting Transmit Byte Registers

The Host programmer should not write to the transmit byte registers, TXH, TXM, or TXL, unless the TXDE bit is set indicating that the transmit byte registers are empty. This guarantees that the transmit byte registers will transfer valid data to the HRX register.
3. Synchronization of Status Bits from DSP to Host

HC, HREQ, DMA, HF3, HF2, TRDY, TXDE, and RXDF (refer to DSP56000/DSP56001 User's Manual, I/O Interface section, Host/ DMA Interface Programming Model for descriptions of these status bits) status bits are set or cleared from inside the DSP and read by the Host processor. The Host can read these status bits very quickly without regard to the clock rate used by the DSP, but the possibility exists that the state of the bit could be changing during the read operation. This is generally not a system problem, since the bit will be read correctly in the next pass of any Host polling routine.

However, if the Host asserts the $\overline{\mathrm{HEN}}$ for more than timing number 31a (T31a), with a minimum cycle time of timing number 32 a (T32a), then the status is guaranteed to be stable.

A potential problem exists when reading status bits HF3 and HF2 as an encoded pair. If the DSP changes HF3 and HF2 from 00 to 11 , there is a small probability that the Host could read the bits during the transition and receive 01 or 10 instead of 11 . If the combination of HF3 and HF2 has significance, the Host could read the wrong combination.

Solution:
a. Read the bits twice and check for consensus.
b. Assert $\overline{\mathrm{HEN}}$ access for T31a so that status bit transitions are stabilized.
4. Overwriting the Host Vector

The Host programmer should change the Host Vector register only when the Host Command bit (HC) is clear. This change will guarantee that the DSP interrupt control logic will receive a stable vector.
5. Cancelling a Pending Host Command Exception

The Host processor may elect to clear the HC bit to cancel the Host Command Exception request at any time before it is recognized by the DSP. Because the Host does not know exactly when the exception will be recognized (due to exception processing synchronization and pipeline delays), the DSP may execute the Host exception after the HC bit is cleared. For these reasons, the HV bits must not be changed at the same time the HC bit is cleared.

## DSP Programmer Considerations

1. Reading HF0 and HF1 as an Encoded Pair

DMA, HF1, HF0, and HCP, HTDE, and HRDF (refer to DSP56000/DSP56001 User's Manual, I/O Interface section, Host/DMA Interface Programming Model for descriptions of these status bits) status bits are set or cleared by the Host processor side of the interface. These bits are individually synchronized to the DSP clock.

A potential problem exists when reading status bits HF1 and HF2 as an encoded pair, i.e., the four combinations 00, 01, 10, and 11 each have significance. A very small probability exists that the DSP will read the status bits synchronized during transition. The solution to this potential problem is to read the bits twice for consensus.

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## DSP56001 Electrical Characteristics

## AC Electrical Characteristics－Host I／O Timing

（ $\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 10 \%, \mathrm{~T}_{\mathrm{J}}=-40$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 20.5 MHz and 27 MHz ）
（ $\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 5 \%, \mathrm{~T}_{\mathrm{J}}=-40$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 33 MHz ）
（see Host Figures 1 through 6）
cyc $=$ Clock cycle $=1 / 2$ instruction cycle $=2 \mathrm{~T}$ cycles
tHSDL $=$ Host Synchronization Delay Time
Active low lines should be＂pulled up＂in a manner consistent with the AC and DC specifications

| Num | Characteristics | 20．5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 30 | Host Synchronous Delay（see Note 1） | tcl | cyc＋tcl | tcl | cyc＋tcl | tcl | cyc＋tcl | ns |
| 31 | HEN／HACK Assertion Width <br> （see Note 2） <br> a．CVR，ICR，ISR Read（see Note 4） <br> b．Read <br> c．Write | $\begin{gathered} c y c+60 \\ 50 \\ 25 \end{gathered}$ | 二 | $\begin{gathered} \text { cyc+46 } \\ 39 \\ 19 \end{gathered}$ | 二 | $\begin{gathered} \text { cyc }+37 \\ 31 \\ 16 \end{gathered}$ | － | $\begin{aligned} & \text { ns } \\ & \text { ns } \\ & \text { ns } \end{aligned}$ |
| 32 | HEN／HACK Deassertion Width （see Note 2 and 5） | 25 | － | 19 | － | 16 | － | ns |
| 32a | Minimum Cycle Time Between Two HEN Assertion for Consecutive CVR， ICR，and ISR Reads（see Note 2） | 2 ＊cyc＋60 | － | 2 ＊cyc＋46 | － | 2 ＊cyc＋37 | － | ns |
| 33 | Host Data Input Setup Time Before HEN／HACK Deassertion | 5 | － | 4 | － | 4 | － | ns |
| 34 | Host Data Input Hold Time After $\overline{\mathrm{HEN}} /$ HACK Deassertion | 5 | － | 4 | － | 4 | － | ns |
| 35 | HEN／HACK Assertion to Output Data Active from High Impedance | 0 | － | 0 | － | 0 | － | ns |
| 36 | HEN／HACK Assertion to Output Data Valid（periodically sampled，and not 100\％tested） | － | 50 | － | 39 | － | 31 | ns |
| 37 | HEN／HACK Deassertion to Output Data High Impedance | － | 35 | － | 27 | － | 22 | ns |
| 38 | Output Data Hold Time After HEN／ HACK Deassertion | 5 | － | 4 | － | 4 | － | ns |
| 39 | HR／W Low Setup Time Before $\overline{\text { HEN }}$ Assertion | 0 | － | 0 | － | 0 | － | ns |
| 40 | HR／W Low Hold Time After HEN Deassertion | 5 | － | 4 | － | 4 | － | ns |
| 41 | HR／产 High Setup Time to $\overline{\mathrm{HEN}}$ Assertion | 0 | － | 0 | － | 0 | － | ns |
| 42 | HR／W High Hold Time After HEN／ HACK Deassertion | 5 | － | 4 | － | 4 | － | ns |
| 43 | HAO－HA2 Setup Time Before HEN Assertion | 0 | － | 0 | － | 0 | － | ns |
| 44 | HAO－HA2 Hold Time After $\overline{H E N}$ Deassertion | 5 | － | 4 | － | 4 | － | ns |
| 45 | DMA HACK Assertion to HREQ Deassertion （see Note 3） | 5 | 60 | 4 | 46 | 4 | 49 | ns |

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## AC Electrical Characteristics - Host I/O Timing (Continued)

$\left(\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 10 \%, \mathrm{~T}_{\mathrm{J}}=-40\right.$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 20.5 MHz and 27 MHz
$\left(\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 5 \%, \mathrm{~T}_{\mathrm{J}}=-40\right.$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 33 MHz ,
see Host Figures 1 through 6)
cyc $=$ Clock cycle $=1 / 2$ instruction cycle $=2 \mathrm{~T}$ cycles
tHSDL = Host Synchronization Delay Time
Active low lines should be "pulled up" in a manner consistent with the AC and DC specifications

| Num | Characteristics | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 46 | DMA FACK Deassertion to $\overline{\text { HREQ }}$ <br> Assertion <br> (see Note 3) <br> for DMA RXL Read <br>  <br> for DMA TXL Write <br> for All Other Cases | $\begin{array}{\|c} \text { tHSDL+cyc } \\ \text { +tch+5 } \\ \text { tHSDL+cyc }+5 \\ 5 \end{array}$ | - | $\begin{array}{\|c} \text { tHSDL+cyc } \\ \text { +tch+4 } \\ \text { tHSDL+cyc }+4 \\ 4 \end{array}$ | - | $\begin{array}{\|c} \text { tHSDL+cyc } \\ \text { +tch+4 } \\ \text { tHSDL+cyc }+4 \\ 4 \end{array}$ | $-$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \\ & \text { ns } \end{aligned}$ |
| 47 | Delay from HEN Deassertion to $\overline{\text { HREQ }}$ Assertion for RXL Read (see Note 3) | $\begin{gathered} \text { tHSDL+cyc } \\ \text { +tch }+5 \end{gathered}$ | - | $\begin{gathered} \text { thSDL+cyc } \\ + \text { tch }+4 \end{gathered}$ | - | $\begin{gathered} \text { tHSDL+cyc } \\ + \text { tch }+4 \end{gathered}$ | - | ns |
| 48 | Delay from HEN Deassertion to HREQ Assertion for TXL Write (see Note 3) | tHSDL+cyc+5 | - | tHSDL+cyc+4 | - | tHSDL+cyc+4 | - | ns |
| 49 | Delay from $\overline{\mathrm{HEN}}$ Assertion to $\overline{\mathrm{HREQ}}$ DeassertionforRXLRead,TXLWrite (see Note 3) | 5 | 75 | 4 | 70 | 4 | 65 | ns |

Notes:

1. "Host synchronization delay (tHSDL)" is the time period required for the

DSP56001 to sample any external asynchronous input signal, determine whether it is high or low, and synchronize it to the DSP56001 internal clock.
2. See HOST PORT USAGE CONSIDERATIONS.
3. HREQ is pulled up by a $1 \mathrm{k} \Omega$ resistor
4. This timing must be adhered to only if two consecutive reads from one of these registers are executed.
5. It is recommended that timing \#32 be $2 c y c+t c h+10$ minimum for $20.5 \mathrm{MHz}, 2 c y c+t c h+7$ minimum for 27 MHz , and 2cyc+tch+6 minimum for 33 MHz if two consecutive writes to TXL are executed without polling TXDE or HREQ.


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## DSP56001 Electrical Characteristics



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## DSP56001 Electrical Characteristics



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## DSP56001 Electrical Characteristics



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## AC Electrical Characteristics - SCI Timing

$\left(\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 10 \%, \mathrm{~T}_{\mathrm{J}}=-40\right.$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 20.5 MHz and 27 MHz ,
$\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 5 \%, \mathrm{~T}_{\mathrm{J}}=-40$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 33 MHz ,
see SCl Figures 1 and 2)
cyc $=$ Clock cycle $=1 / 2$ instruction cycle $=2 \mathrm{~T}$ cycles
tSCC = Synchronous Clock Cycle Time (for internal clock tSCC is determined by the SCI clock control register and Icyc.)
SCI Synchronous Mode Timing

| Num | Characteristics | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 55 | Synchronous Clock Cycle - tSCC | 8ぇсуc | - | 8* сус | - | 8ぇсус | - | ns |
| 56 | Clock Low Period | 4* сус-20 | - | 4* ${ }_{\text {cyc-15 }}$ | - | 4* cyc-13 | - | ns |
| 57 | Clock High Period | 4* сус-20 | - | 4*cyc-15 | - | 4* cyc-13 | - | ns |
| 59 | Output Data Setup to Clock Falling Edge (Internal Clock) | $\begin{gathered} 2_{\star} \mathrm{cyc} \\ + \text { tcl-50 } \end{gathered}$ | - | $\begin{gathered} \text { 2_cyc } \\ \text { +tcl-39 } \end{gathered}$ | - | $\begin{gathered} 2 \times \mathrm{cyc} \\ +\mathrm{tcl}-31 \end{gathered}$ | - | ns |
| 60 | Output Data Hold After Clock Rising Edge (Internal Clock) | $\begin{gathered} 2 \star \mathrm{cyc} \\ -\mathrm{tc}-15 \end{gathered}$ | - | $\begin{gathered} 2 \times \mathrm{cyc} \\ -\mathrm{tc}-11 \end{gathered}$ | - | $\begin{aligned} & \text { 2^cyc } \\ & \text {-tcl-9 } \end{aligned}$ | - | ns |
| 61 | Input Data Setup Time Before Clock Rising Edge (Internal Clock) | $\begin{gathered} \text { 2^cyc } \\ +\mathrm{tc}+45 \end{gathered}$ | - | $\begin{gathered} \substack{\text { 2.cyc } \\ \text { +tclac } \\ \hline \\ \hline} \end{gathered}$ | - | $\begin{gathered} \substack{\text { 2cyc } \\ \text { +tcl+ }+28} \end{gathered}$ | - | ns |
| 62 | Input Data Not Valid Before Clock Rising Edge (Internal Clock) | - | $\begin{gathered} 2 \star \mathrm{cyc} \\ +\mathrm{tcl}-10 \end{gathered}$ | - | $\begin{aligned} & 2_{\star} \mathrm{cyc} \\ & +\mathrm{tcl}-8 \end{aligned}$ | - | $\begin{aligned} & 2 \times \mathrm{cyc} \\ & +\mathrm{tcl}-6 \end{aligned}$ | ns |
| 63 | Clock Falling Edge to Output Data Valid (External Clock) | - | 63 | - | 48 | - | 39 | ns |
| 64 | Output Data Hold After Clock Rising Edge (External Clock) | cyc+12 | - | cyc+9 | - | cyc+8 | - | ns |
| 65 | Input Data Setup Time Before Clock Rising Edge (External Clock) | 30 | - | 23 | - | 19 | - | ns |
| 66 | Input Data Hold Time After Clock Rising Edge (External Clock) | 40 | - | 31 | - | 25 | - | ns |

# Freescale Semiconductor, Inc. 

## DSP56001 Electrical Characteristics

## AC Electrical Characteristics - SCI Timing

$\left(\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 10 \%, \mathrm{~T}_{\mathrm{J}}=-40\right.$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 20.5 MHz and 27 MHz ,
$\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 5 \%, \mathrm{~T}_{\mathrm{J}}=-40$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 33 MHz ,
see SCI Figures 1 and 2)
cyc $=$ Clock cycle $=1 / 2$ instruction cycle $=2 \mathrm{~T}$ cycles
tACC = Asynchronous clock cycle time
tACC = Asynchronous Clock Cycle Time (for internal clock tACC is determined by the SCl clock control register and Icyc)
SCI Asynchronous Mode Timing - 1X Clock

| Num | Characteristics | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 67 | Asynchronous Clock Cycle | 64*cyc | - | 64*cyc | - | 64*cyc | - | ns |
| 68 | Clock Low Period | 32* ${ }^{\text {cyc-20 }}$ | - | 32**yc-15 | - | 32**yc-13 | - | ns |
| 69 | Clock High Period | 32_ ${ }^{\text {cyc-20 }}$ | - | 32_cyc-15 | - | 32_cyc-13 | - | ns |
| 71 | Output Data Setup to Clock Rising Edge (Internal Clock) | $\begin{gathered} \hline 32 \text { сyc } \\ -100 \end{gathered}$ | - | $\begin{gathered} \hline 32_{\text {_cyc }} \\ -77 \end{gathered}$ | - | $\begin{gathered} \hline 32 \text { суc } \\ -61 \end{gathered}$ | - | ns |
| 72 | Output Data Hold After Clock Rising Edge (Internal Clock) | $\begin{gathered} \hline 32 \text { _cyc } \\ -100 \end{gathered}$ | - | $\begin{gathered} \hline 32 \text { cyc } \\ -77 \end{gathered}$ | - | $\begin{gathered} \hline 32 \text { _cyc } \\ -61 \end{gathered}$ | - | ns |

## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics



SCI Figure 1. SCI Synchronous Mode Timing

Freescale Semiconductor, Inc.
DSP56001 Electrical Characteristics


## Freescale Semiconductor，Inc．

## DSP56001 Electrical Characteristics

## AC Electrical Characteristics－SSI Timing

$\left(\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 10 \%, \mathrm{~T}_{\mathrm{J}}=-40\right.$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 20.5 MHz and 27 MHz ，
$\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 5 \%, \mathrm{~T}_{\mathrm{J}}=-40$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 33 MHz ，
see SSI Figures 1 and 2）
cyc $=$ Clock cycle $=1 / 2$ instruction cycle $=2 \mathrm{~T}$ cycles
tSSICC＝SSI clock cycle time
TXC（SCK Pin）＝Transmit Clock
RXC（SC0 or SCK Pin）＝Receive Clock
FST（SC2 Pin）＝Transmit Frame Sync
FSR（SC1 or SC2 Pin）＝Receive Frame Sync
i ck＝Internal Clock
x ck＝External Clock
g ck＝Gated Clock
i ck a＝Internal Clock，Asynchronous Mode（Asynchronous implies that TXC and RXC are two different clocks）
i ck s＝Internal Clock，Synchronous Mode（Synchronous implies that TXC and RXC are the same clock）
bl＝bit length
wl＝word length

| Num | Characteristics | 20．5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 80 | Clock Cycle（see Note 1） | 4＊cyc | － | 4＊cyc | － | $4{ }_{\text {＊}} \mathrm{cyc}$ | － | ns |
| 81 | Clock High Period | 2＿cyc－20 | － | 2＊＊yc－15 | － | 2＊${ }^{\text {cyc－13 }}$ | － | ns |
| 82 | Clock High Period | 2＊cyc－20 | － | 2＊${ }^{\text {cyc－15 }}$ | － | $2_{\star}$ cyc－13 | － | ns |
| 84 | RXC Rising Edge to FSR Out（bl）High xck ick a | － | $\begin{aligned} & 80 \\ & 50 \end{aligned}$ | 二 | $\begin{aligned} & 61 \\ & 38 \end{aligned}$ | 二 | $\begin{aligned} & 48 \\ & 31 \end{aligned}$ | ns ns |
| 85 | RXC Rising Edge to FSR Out（bl）Low x ck i ck a | － | $\begin{aligned} & 70 \\ & 40 \end{aligned}$ | － | $\begin{aligned} & 54 \\ & 31 \end{aligned}$ | － | $\begin{aligned} & 43 \\ & 25 \end{aligned}$ | ns ns |
| 86 | RXC Rising Edge to FSR Out（wl）High x ck ick a | － | $\begin{aligned} & 70 \\ & 40 \end{aligned}$ | － | $\begin{aligned} & 54 \\ & 31 \end{aligned}$ | － | $\begin{aligned} & 43 \\ & 25 \end{aligned}$ | ns ns |
| 87 | RXC Rising Edge to FSR Out（wl）Low x ck i ck a | － | $\begin{aligned} & 70 \\ & 40 \end{aligned}$ | 二 | $\begin{aligned} & 54 \\ & 31 \end{aligned}$ | 二 | $\begin{aligned} & 43 \\ & 25 \end{aligned}$ | ns ns |
| 88 | Data In Setup Time Before RXC（SCK in Synchronous Mode）Falling Edge x ck ick a ick s | $\begin{aligned} & 15 \\ & 35 \\ & 25 \end{aligned}$ | － | $\begin{aligned} & 12 \\ & 27 \\ & 19 \end{aligned}$ | 二 | $\begin{aligned} & 10 \\ & 22 \\ & 16 \end{aligned}$ | 二 | $\begin{aligned} & \text { ns } \\ & \text { ns } \\ & \text { ns } \end{aligned}$ |
| 89 | Data In Hold Time After RXC FallingEdgeck <br> ick a | $\begin{gathered} 35 \\ 5 \end{gathered}$ | － | $\begin{gathered} 27 \\ 4 \end{gathered}$ | － | $\begin{gathered} 22 \\ 4 \end{gathered}$ | － | ns ns |
| 90 |  | $\begin{aligned} & 15 \\ & 35 \end{aligned}$ | 二 | $\begin{aligned} & 12 \\ & 27 \end{aligned}$ | 二 | $\begin{aligned} & 10 \\ & 23 \end{aligned}$ | － | ns ns |
| 91 | FSR Input（wl）High Before RXC Falling Edge $\quad \mathrm{xck}$ i ck a | $\begin{aligned} & 20 \\ & 55 \end{aligned}$ | 二 | $\begin{aligned} & 15 \\ & 42 \end{aligned}$ | － | $\begin{aligned} & 13 \\ & 34 \end{aligned}$ | － | ns ns |
| 92 | FSR Input Hold Time After RXC Falling Edge $\quad \mathrm{ck}$ ick a | $\begin{gathered} 35 \\ 5 \end{gathered}$ | － | $\begin{gathered} 27 \\ 4 \end{gathered}$ | － | $\begin{gathered} 22 \\ 4 \end{gathered}$ | － | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |

## Freescale Semiconductor，Inc．

## DSP56001 Electrical Characteristics

AC Electrical Characteristics－SSI Timing（Continued）

| Num | Characteristics | 20．5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 93 | Flags Input Setup Before RXC Falling Edge $\begin{aligned} \mathrm{ck} \\ \mathrm{i} \mathrm{ck} \mathrm{a}\end{aligned}$ | $\begin{aligned} & 30 \\ & 50 \end{aligned}$ | - | $\begin{aligned} & 23 \\ & 39 \end{aligned}$ | - | $\begin{aligned} & 19 \\ & 31 \end{aligned}$ | - | $\begin{gathered} \mathrm{ns} \\ \mathrm{nss} \end{gathered}$ |
| 94 | Flags Input Hold Time After RXC Falling Edge | $\begin{gathered} 35 \\ 5 \end{gathered}$ | － | $\begin{gathered} 27 \\ 4 \end{gathered}$ | － | $\begin{gathered} 22 \\ 4 \end{gathered}$ | 二 | ns |
| 95 | TXC Rising Edge to FST Out（bl）High $\begin{array}{r}\text { ck } \\ \text { i ck a }\end{array}$ | － | $\begin{aligned} & 70 \\ & 30 \end{aligned}$ | － | $\begin{aligned} & 54 \\ & 23 \end{aligned}$ | － | $\begin{aligned} & 43 \\ & 19 \end{aligned}$ | ns ns |
| 96 | $\begin{array}{\|c\|} \hline \text { TXC Rising Edge to FST Out (bl) Low } \\ \times \mathrm{ck} \\ \mathrm{i} \text { ck a } \end{array}$ | － | $\begin{aligned} & 65 \\ & 35 \end{aligned}$ | － | $\begin{aligned} & 50 \\ & 27 \end{aligned}$ | － | $\begin{aligned} & 40 \\ & 22 \end{aligned}$ | ns ns |
| 97 | TXC Rising Edge to FST Out（wl）High xck ick a | 二 | $\begin{aligned} & 65 \\ & 35 \end{aligned}$ | 二 | $\begin{aligned} & 50 \\ & 27 \end{aligned}$ | 二 | $\begin{aligned} & 40 \\ & 22 \end{aligned}$ | ns ns |
| 98 | TXC Rising Edge to FST Out（wl）Low x ck i ck a | － | $\begin{aligned} & 65 \\ & 35 \end{aligned}$ | － | $\begin{aligned} & 50 \\ & 27 \end{aligned}$ | － | $\begin{aligned} & 40 \\ & 22 \end{aligned}$ | ns ns |
| 99 | TXC Rising Edge to Data Out Enable from High Impedance | － | $\begin{aligned} & 65 \\ & 40 \end{aligned}$ | － | $\begin{aligned} & 50 \\ & 31 \end{aligned}$ | 二 | $\begin{aligned} & 40 \\ & 25 \end{aligned}$ | ns ns |
| 100 | TXC Rising Edge to Data Out Valid x ck ick a | － | $\begin{aligned} & 65 \\ & 40 \end{aligned}$ | － | $\begin{aligned} & 50 \\ & 31 \end{aligned}$ | － | $\begin{aligned} & 40 \\ & 25 \end{aligned}$ | ns ns |
| 101 | TXC Rising Edge to Data Out High Impedance（periodically sampled，and not $100 \%$ tested）xck ick a | － | $\begin{aligned} & 70 \\ & 40 \end{aligned}$ | － | $\begin{aligned} & 54 \\ & 31 \end{aligned}$ | － | $\begin{aligned} & 43 \\ & 25 \end{aligned}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| 101a | TXC Falling Edge to Data Out High Impedance for Gated Clock Mode Only g ck | cyc＋tch | － | cyc＋tch | － | cyc＋tch | － | ns |
| 102 | FST Input（bI）Setup Time Before TXC Falling Edge i ck a | $\begin{aligned} & 15 \\ & 35 \end{aligned}$ | － | $\begin{aligned} & 12 \\ & 27 \end{aligned}$ | － | $\begin{aligned} & 10 \\ & 23 \end{aligned}$ | － | ns ns |
| 103 | FST Input（wl）to Data Out Enable from High Impedance | － | 60 | － | 46 | － | 37 | ns |
| 104 | FST Input（wl）Setup Time Before TXC <br> Falling Edge <br>  <br>  <br>  <br> x ck <br> i ck a$\|$ | $\begin{aligned} & 20 \\ & 55 \end{aligned}$ | － | $\begin{aligned} & 15 \\ & 42 \end{aligned}$ | － | $\begin{aligned} & 13 \\ & 34 \end{aligned}$ | － | ns ns |
| 105 | FST Input Hold Time After TXC Falling Edge $\begin{array}{r}\mathrm{ck} \\ \mathrm{i} \mathrm{ck} \mathrm{a}\end{array}$ | $\begin{gathered} 35 \\ 5 \end{gathered}$ | － | $\begin{gathered} 27 \\ 4 \end{gathered}$ | － | $\begin{gathered} 22 \\ 4 \end{gathered}$ | － | ns ns |
| 106 | Flag Output Valid After TXC Rising Edge | － | $\begin{aligned} & 70 \\ & 40 \end{aligned}$ | － | $\begin{aligned} & 54 \\ & 31 \end{aligned}$ | － | $\begin{aligned} & 43 \\ & 25 \end{aligned}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |

## Note：

1．For internal clock，External Clock Cycle is defined by Icyc and SSI control register．

## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics



## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics



Note:

1. In the Network mode, output flag transitions can occur at the start of each time slot within the frame. In the Normal mode, the output flag state is asserted for the entire frame period.

SSI Figure 2. SSI Transmitter Timing

## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics

## AC Electrical Characteristics <br> Capacitance Derating - External Bus Asynchronous Timing

$\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 10 \%, \mathrm{~T}_{\mathrm{J}}=-40$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 20.5 MHz and 27 MHz ,
$\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 5 \%, \mathrm{~T}_{\mathrm{J}}=-40$ to $+105^{\circ} \mathrm{C}, \mathrm{CL}=50 \mathrm{pf}+1 \mathrm{TTL}$ Load at 33 MHz , see Bus Figures 1 and 2
cyc $=$ Clock cycle $=1 / 2$ instruction cycle $=2 \mathrm{~T}$ cycles
WS = Number of Wait States, Determined by BCR Register (WS = 0 to 15)
The DSP56001 External Bus Timing Specifications are designed and tested at the maximum capacitive load of 50 pf , including stray capacitance. Typically, the drive capability of the External Bus pins (A0-A15, D0-D23, $\overline{P S}, \overline{D S}, \overline{R D}, \overline{W R}, X / \bar{Y}$ ) derates linearly at 1 ns per 12 pf of additional capacitance from 50 pf to 250 pf of loading. Port $B$ and $C$ pins derate linearly at 1 ns per 5 pf of additional capacitance from 50 pf to 250 pf of loading.

Active low inputs should be "pulled up" in a manner consistent with the AC and DC specifications.
To conserve power, when an internal memory access follows an external memory access, the $\overline{R D}$ and $\overline{W R}$ strobes remain deasserted and A0-A15 and $\mathrm{X} \overline{\mathrm{Y}}$ do not change from their previous state. Both $\overline{\mathrm{PS}}$ and $\overline{\mathrm{DS}}$ will be deasserted (they do not change between two external accesses to the same memory space) indicating that no external memory access is occurring. If $\overline{\mathrm{BR}}$ has been asserted, then the bus signals will be three-stated according to the timing information in this data sheet.

| Num | Characteristics | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 115 | Delay from $\overline{\mathrm{BR}}$ Assertion to $\overline{\mathrm{BG}}$ <br> Assertion <br> (see Note 1) <br>  <br> (see Note 2) <br>  <br> (see Note 3) <br>  <br> (see Note 4) <br> (see Note 5) | 2 * cyc+tch <br> cyc+tch <br> cyc+tch <br> Infinity tch+4 | $\begin{gathered} 4^{*} \text { cyc } y+\text { tch }+ \\ 20 \\ 4^{*} \text { cyc+tch }+ \\ \text { cyc }{ }^{*} \text { WS }+20 \\ 6^{*} \text { cyc+tch }+ \\ 2^{\star} \text { cyc } c^{*} W S+ \\ 20 \\ - \\ \text { cyc+tch }+30 \end{gathered}$ | 2 * cyc+tch <br> cyc+tch <br> cyc+tch <br> Infinity <br> tch+3 | $\begin{aligned} & 4^{*} \text { cyc }+ \text { tch }+ \\ & 15 \\ & 4^{*} \text { cyc+tch+ } \\ & \text { cyc*WS }+15 \\ & 6^{*} \text { cyc tch+ } \\ & 2^{*} \text { cyc }{ }^{*} W S+ \\ & 15 \\ & \frac{-}{c y c}+\text { tch }+23 \end{aligned}$ | 2 * cyc+tch <br> cyc+tch <br> cyc+tch <br> Infinity tch+3 | $\begin{gathered} 4^{*} \text { cyc }+ \text { tch }+ \\ 13 \\ 4^{*} c y c+t c h+ \\ \text { cyc*WS }+13 \\ 6^{*} \text { cyctch+ } \\ 2^{*} \text { cyc*WS }+ \\ 13 \\ - \\ \text { cyc+tch }+19 \end{gathered}$ | ns <br> ns <br> ns <br> ns ns |
| 116 | Flags Input Hold Time After RXC Falling Edge Deassertion | $2^{*} \mathrm{cyc}$ | 4*cyc+20 | $2^{*} \mathrm{cyc}$ | $4^{*} \mathrm{cyc}+15$ | 2*cyc | $4^{*} \mathrm{cyc}+13$ | ns |
| 117 | $\overline{\text { BG }}$ Deassertion Duration | 2*cyc-10 | - | 2*cyc-8 | - | 2*cyc-6 | - | ns |
| 118 | Delay from Address, Data, and Control Bus High Impedance to $\overline{B G}$ Assertion | 0 | - | 0 | - | 0 | - | ns |
| 119 | Delay from $\overline{\mathrm{BG}}$ Deassertion to Address, Data, and Control Bus Enabled | - | tch-10 | - | tch-8 | - | tch-6 | ns |
| 120 | $\begin{array}{ll}\text { Address Valid to } \overline{\mathrm{WR}} \text { Assertion } & \begin{array}{l}\text { WS }=0 \\ \mathrm{WS}>0\end{array} \\ & \text { WS }\end{array}$ | $\begin{aligned} & \hline \text { tcl-9 } \\ & \text { cyc-9 } \end{aligned}$ | $\begin{gathered} \mathrm{tcl}+5 \\ \mathrm{cyc}+5 \end{gathered}$ | $\begin{gathered} \text { tcl-7 } \\ \text { cyc-7 } \end{gathered}$ | $\begin{aligned} & \mathrm{tcl}+5 \\ & \mathrm{cyc}+5 \end{aligned}$ | $\begin{gathered} \text { tcl-5.5 } \\ \text { cyc-5.5 } \end{gathered}$ | tcl+5 <br> $\mathrm{cyc}+5$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 121 | $\begin{array}{ll}\text { WR Assertion Width } & \text { WS }=0 \\ & \text { WS>0 }\end{array}$ | cyc-9 WS*cyc +tcl-9 | - | cyc-7 WS*cyc $+\mathrm{tcl}-7$ | - | cyc-5.0 W ${ }^{*}$ cyc +tcl- 5.0 | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 122 | $\overline{\text { WR }}$ Deassertion to Address Not Valid | tch-12 | - | tch-9 | - | tch-7.5 | - | ns |
| 123 | $\overline{\text { WR }}$ Assertion to Data Out Valid WS $=0$ WS>0 | $\begin{gathered} \text { tch-9 } \\ 0 \end{gathered}$ | $\begin{gathered} \text { tch }+10 \\ 10 \end{gathered}$ | $\begin{gathered} \text { tch-7 } \\ 0 \end{gathered}$ | $\begin{gathered} \text { tch }+8 \\ 8 \end{gathered}$ | $\begin{gathered} \text { tch-5.5 } \\ 0 \end{gathered}$ | $\begin{gathered} \text { tch }+6.5 \\ 6.5 \end{gathered}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| 124 | Data Out Hold Time from $\overline{W R}$ Deassertion (The maximum specification is periodically sampled, and not 100\% tested.) | tch-9 | tch+7 | tch-7 | tch+6 | tch-5.5 | tch+4.5 | ns |
| 125 | Data Out Setup Time to $\overline{\mathrm{WR}}$ Deassertion (see Note 6) $\begin{aligned} & W S=0 \\ & W S>0 \end{aligned}$ | tcl-5 WS*cyc +tcl-5 | - | tcl-5 WS*cyc $+t \mathrm{cl}-5$ | - | tcl-5 WS*cyc +tcl-5 | - | ns ns |
| 126 | $\overline{\mathrm{RD}}$ Deassertion to Address Not Valid | tch-9 | - | tch-7 | - | tch-5.5 | - | ns |

# Freescale Semiconductor, Inc. 

## DSP56001 Electrical Characteristics AC Electrical Characteristics - External Bus Asynchronous Timing (Continued)

| Num | Characteristics |  | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Max | Min | Max |  |
| 127 | Address Valid to $\overline{\mathrm{RD}}$ deassertion | $\begin{aligned} & \hline W S=0 \\ & W S>0 \end{aligned}$ | cyc+tcl-8 ((WS+1) cyc) $+\mathrm{tcl}-\mathbf{8}$ | - | cyc+tcl-6 ((WS+1) cyc)+tcl-6 | - | cyc+tcl-6 ((WS+1) cyc) $+\mathrm{tcl}-6$ | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 128 | Input Data Hold Tim Deassertion |  | 0 | - | 0 | - | 0 | - | ns |
| 129 | $\overline{\mathrm{RD}}$ Assertion Width | $\begin{aligned} & W S=0 \\ & W S>0 \end{aligned}$ | $\begin{gathered} \text { cyc-9 } \\ \left((\mathrm{WS}+1)^{*}\right. \\ \text { cyc) }-9 \end{gathered}$ | - | $\begin{gathered} \text { cyc-7 } \\ \left((\mathrm{WS}+1)^{*}\right. \\ \text { cyc })-7 \end{gathered}$ | 二 | $\begin{gathered} \text { cyc-5.5 } \\ \left((\mathrm{WS}+1)^{*}\right. \\ \text { cyc)-5.5 } \end{gathered}$ | - | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| 130 | Address Valid to Input Data Valid | $\begin{aligned} & \hline W S=0 \\ & W S>0 \end{aligned}$ | - | cyc+tcl-18 ((WS+1) cyc)+tcl-18 | - | cyc+tcl-14 ((WS+1) cyc)+tcl-14 | - | cyc+tcl-11 ((WS+1) cyc)+tcl-11 | $\mathrm{ns}$ |
| 131 | Address Valid to $\overline{\mathrm{RD}}$ |  | tcl-9 | tcl+5 | tcl-7 | tcl+5 | tcl-5.5 | tcl+5 | ns |
| 132 | $\overline{\mathrm{RD}}$ Assertion to Input Data Valid | $\begin{aligned} & \text { WS }=0 \\ & W S>0 \end{aligned}$ | 二 | cyc-14 <br> ((WS+1)* <br> сус)-14 | - | $\begin{gathered} \text { cyc-11 } \\ \left((\mathrm{WS}+1)^{\star}\right. \\ \text { cyc) }) \end{gathered}$ | - | $\begin{gathered} \text { cyc-9 } \\ \left((\mathrm{WS}+1)^{*}\right. \\ \text { cyc)-9 } \end{gathered}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 133 | $\overline{\mathrm{WR}}$ Deassertion to $\overline{\mathrm{RD}}$ Assertion |  | cyc-15 | - | cyc-12 | - | cyc-10 | - | ns |
| 134 | $\overline{\mathrm{RD}}$ Deassertion to $\overline{\mathrm{RD}}$ Assertion |  | cyc-10 | - | cyc-8 | - | cyc-6.5 | - | ns |
| 135 | WR Deassertion to $\overline{W R}$ Assertion | $\begin{aligned} & \text { WS }=0 \\ & W S>0 \end{aligned}$ | $\begin{gathered} \text { cyc-15 } \\ \text { cyc+tch-15 } \end{gathered}$ | - | $\begin{gathered} \text { cyc-12 } \\ \text { cyc+tch-12 } \end{gathered}$ | - | $\begin{gathered} \text { cyc-10 } \\ \text { cyc+tch-10 } \end{gathered}$ | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 136 | $\overline{\mathrm{RD}}$ Deassertion to $\overline{W R}$ Assertion | $\begin{gathered} \hline W S=0 \\ W S>0 \end{gathered}$ | $\begin{gathered} \text { cyc-10 } \\ \text { cyc+tch-10 } \end{gathered}$ | - | $\begin{gathered} \text { cyc-8 } \\ \text { cyc+tch-8 } \end{gathered}$ | - | cyc-6.5 cyc+tch6.5 | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |

Notes:

1. With no external access from the DSP.
2. During external read or write access.
3. During external read-modify-write access.
4. During the STOP mode the external bus will not be released and $\overline{\mathrm{BG}}$ will not go low. However, if the bus is released $(\overline{B G}=0)$ and the STOP instruction is executed while $\overline{B G}=0$ then the bus will remain released while the DSP is in the stop state and $\overline{B G}$ will remain low.
5. During the WAIT mode the $\overline{\mathrm{BR}} / \overline{\mathrm{BG}}$ circuits remain active.
6. Typical values at 5 V are: at 20.5 MHz and $\mathrm{WS}=0, \quad \mathrm{Min}=$
tcl-4

| at 20.5 | MHz and $\mathrm{WS}>0$, | $\mathrm{Min}=$ | $\mathrm{WS}_{*}$ cyc + tcl- -4 |
| :--- | :--- | :--- | :--- |
| at 27 | MHz and $\mathrm{WS}=0$, | $\mathrm{Min}=$ | tcl-3 |
| at 27 | MHz and $\mathrm{WS}>0$, | $\mathrm{Min}=$ | $\mathrm{WS}_{*} \mathrm{cyc}+\mathrm{tcl}-3$ |
| at 33 | MHz and $\mathrm{WS}=0$, | $\mathrm{Min}=$ | tcl- 2.5 |
| at 33 | MHz and $\mathrm{WS}>0$, | $\mathrm{Min}=$ | $\mathrm{WS}_{*} \mathrm{cyc}+\mathrm{tcl}-2.5$ |

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## DSP56001 Electrical Characteristics



A0-A15, $\overline{\mathrm{DS}}$,
$\overline{\mathrm{PS}}, \mathrm{X} / \overline{\mathrm{Y}}$
(See Note 1)


Note:

1. During Read-Modify-Write instructions and internal instructions, the address lines do not change state.

Async. Bus Figure 2. External Bus Asynchronous Timing

# Freescale Semiconductor, Inc. 

## DSP56001 Electrical Characteristics

## AC Electrical Characteristics - External Bus Synchronous Timing

$\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 10 \% ; \mathrm{T}_{\mathrm{J}}=-40$ to $105^{\circ} \mathrm{C}$ at 20.5 MHz 27 MHz
$\mathrm{Vcc}=5.0 \mathrm{Vdc} \pm 5 \% ; \mathrm{T}_{\mathrm{J}}=-40$ to $105^{\circ} \mathrm{C}$ at 33 MHz

| Num | Characteristics | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 140 | CIk Low Transition To Address Valid | - | 24 | - | 19 | - | 19 | ns |
| 141 | CIk High Transition To $\overline{W R}$ WS $=0$ <br> Assertion (see Note 2) WS $>0$ | $\begin{aligned} & 0 \\ & 0 \end{aligned}$ | $\begin{gathered} 19 \\ \text { tch }+19 \end{gathered}$ | $\begin{aligned} & 0 \\ & 0 \end{aligned}$ | $\begin{gathered} 15 \\ \text { tch }+15 \end{gathered}$ | $\begin{aligned} & 0 \\ & 0 \end{aligned}$ | $\begin{gathered} 17 \\ \text { tch+17 } \end{gathered}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| 142 | Clk High Transition To WR Deassertion | 5 | 21 | 5 | 16 | 5 | 13 | ns |
| 143 | Clk High Transition To $\overline{\mathrm{RD}}$ Assertion | 0 | 19 | 0 | 15 | 0 | 16 | ns |
| 144 | Clk High Transition To $\overline{\mathrm{RD}}$ Deassertion | 5 | 17 | 5 | 13 | 4.5 | 10.5 | ns |
| 145 | Clk Low Transition To Data-Out Valid | - | 25 | - | 19 | - | 19 | ns |
| 146 | CIk Low Transition To Data-Out Invalid (see Note 3) | 5 | - | 4 | - | 3.5 | - | ns |
| 147 | Data-In Valid To Clk High Transition (Setup) | 0 | - | 0 | - | 0 | - | ns |
| 148 | Clk High Transition To Data-In Invalid (Hold) | 12 | - | 12 | - | 13 | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 149 | CIk Low To Address Invalid (see Note 3) | 3 | - | 3 | - | 3 | - | ns |

Notes:

1. AC timing specifications which are referenced to a device input signal are measured in production with respect to the $50 \%$ point of the respective input signal's transition.
2. WS are wait state values specified in the BCR.
3. Clk low to data-out invalid (spec. 146) and Clk low to address invalid (spec. 149) indicate the time after which data/address are no longer guaranteed to be valid.

## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics


Sync. Bus Figure 1. DSP56001 Synchronous Bus Timing

Note: During Read-Modify-Write Instructions, the address lines do not change states.

## DSP56001 Electrical Characteristics

## AC Electrical Characteristics - Bus Strobe / Wait Timing

| Num | Characteristics | 20.5 MHz |  | 27 MHz |  | 33 MHz |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| 150 | Clk Low Transition To $\overline{\mathrm{BS}}$ Assertion | 4 | 24 | 3 | 19 | 2.5 | 19 | ns |
| 151 | WT Assertion To CIk Low Transition (setup time) | 4 | - | 3 | - | 2.5 | - | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 152 | CIk Low Transition To WT Deassertion For Minimum Timing | 14 | cyc-8 | 11 | cyc-6 | 12 | cyc-5 | ns |
| 153 | WT Deassertion To CIk Low Transition For Maximum Timing (2 wait states | 8 | - | 6 | - | 5 | - | ns |
| 154 | CIk High Transition To $\overline{\text { BS }}$ Deassertion | 5 | 26 | 4 | 20 | 3.5 | 19 | ns |
| 155 | $\overline{\overline{B S}}$ Assertion To Address Valid | -2 | 10 | -2 | 8 | -2 | 6.5 | ns |
| 156 | BS Assertion To WT Assertion (see Note 2) | 0 | cyc-15 | 0 | cyc-11 | 0 | cyc-10 | ns |
| 157 | $\begin{array}{ll}\overline{\mathrm{BS}} \text { Assertion To WT Deassertion } \\ \text { (See Note } 2 \text { and Note 4) } & \text { WS } \leq 2 \\ & \text { WS }>2\end{array}$ | cyc (WS-1) * cyc | 2*cyc-15 <br> WS*cyc -15 | cyc (WS-1) * cyc | 2*cyc-11 <br> WS*cyc -11 | cyc+4 (WS-1) * cyc+4 | 2*cyc-10 WS*cyc -10 | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| 158 | $\overline{\text { WT }}$ Deassertion To $\overline{\overline{S S}}$ Deassertion | cyc+tcl | $\begin{gathered} 2_{\star} \mathrm{cyc}+\mathrm{tcl} \\ +23 \end{gathered}$ | cyc+tcl | $\begin{gathered} 2_{\star} \mathrm{cyc}+\mathrm{tcl} \\ +17 \end{gathered}$ | cyc+tcl | $\begin{gathered} 2_{\star} \text { cyc+tcl } \\ +15 \end{gathered}$ | ns |
| 159 | Minimum $\overline{\mathrm{BS}}$ Deassertion Width For Consecutive External Accesses | tch-7 | - | tch-6 | - | tch-4.5 | - | ns |
| 160 | $\overline{B S}$ Deassertion To Address Invalid (see Note 3) | tch-10 |  | tch-8 |  | tch-6.5 |  |  |
| 161 | Data-In Valid to RD Deassertion (Set Up) | 16 | - | 12 | - | 10 | - | ns |

## Note:

1. AC timing specifications which are referenced to a device input signal are measured in production with respect to the $50 \%$ point of the respective input signal's transition.
2. If wait states are also inserted using the BCR and if the number of wait states is greater than 2 , then specification numbers 156 and 157 can be increased accordingly.
3. $\overline{\mathrm{BS}}$ deassertion to address invalid indicates the time after which the address are no longer guaranteed to be valid.
4. The minimum number of wait states when using $\overline{\mathrm{BS}} / \overline{\mathrm{WT}}$ is two (2).
5. For read-modify-write instructions, the address lines will not change states between the read and the write cycle. However, $\overline{B S}$ will deassert before asserting again for the write cycle. If wait states are desired for each of the read and write cycle, the $\overline{\mathrm{WT}}$ pin must be asserted once for each cycle.

## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics



Bus Arbitration Figure 1. DSP56001 Synchronous BS / WT Timings

Note: During Read-Modify-Write Instructions, the address lines do not change state.
However, $\overline{B S}$ will deassert before asserting again for the write cycle.

## Freescale Semiconductor, Inc.

## DSP56001 Electrical Characteristics

A0-A15, $\overline{\mathrm{PS}}, \overline{\mathrm{DS}}$, $X \bar{Y}$
$\overline{B S}$
$\overline{\mathrm{WT}}$
$\overline{R D}$

D0-D23
$\overline{W R}$

D0-D23


Bus Arbitration Figure 2. DSP56001 Asynchronous $\overline{\text { BS }} / \overline{\text { WT Timings }}$

Note: During Read-Modify-Write Instructions, the address lines will not change states. However, $\overline{B S}$ will deassert before asserting again for the write cycle.

# Freescale Semiconductor, Inc. 

## DSP56001 Electrical Characteristics

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## APPENDIX A

ORDERING INFORMATION


| DSP56001 SOCKET INFORMATION |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| PGA |  |  |  |  |
| Supplier | Telephone | Socket Type | Part Number | Comment |
| Advanced Interconnections |  |  |  |  |
|  | (401) 823-5200 | Standard 88 Pin | 4CS088-01TG ${ }^{2}$ | Includes Cutout in Center |
| AMP |  |  |  |  |
| (717) 564-0100 |  | Standard 88 Pin | 1-916223-3 | Low Insertion Force |
|  |  | 1-55283-9 | ZIF Production |
|  |  | Standard 128 Pin | 1-55383-4 | ZIF Burn-In and Test |
| Robinson Nugent |  |  |  |  |
|  | (812) 945-0211 |  | Custom Pinout | PGA-088CM3P-S-TG ${ }^{3}$ |  |
|  |  | PGA-088CHP3-SL-TG ${ }^{3}$ |  | High Temp, Longer Leads |
| Samtec |  |  |  |  |
|  | (812) 944-6733 | Standard 120 Pin | MVAS-120-ZSTT-131 | Includes Cutout in Center |
|  |  | Custom 88 Pin | CPAS-88-ZSTT-13BF ${ }^{1}$ | No Cutout |
|  | NOTES: |  |  |  |
| 1. | Please specify wirewrap and plating options. The part numbers shown specify low profile solder tail pins having a tin contact and tin shell. |  |  |  |
| 2. | Please specify wirewrap and plating options. The part number shown specifies gold contact and tin shell. |  |  |  |
|  |  |  |  |  |  |  |

## CQFP

| Supplier | Telephone | Socket Type | Part Number |
| :--- | :--- | :--- | :--- |
| AMP |  |  | Comment |
|  | $(717) 564-0100$ | - | $822054-2^{1}$ | | Converts CQFP to fit AMP's |
| :--- |
|  |

NOTES:

1. This part is not a socket. It is a converter that allows a CQFP part to be used in the PQFP socket described below.

PQFP

| Supplier | Telephone | Socket Type | Part Number |
| :--- | :--- | :--- | :--- |
| AMP | $(717) 564-0100$ | 132 Pin | $821949-5^{1}$ |

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| PIN ASSIGNMENT |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| N | $\longdiv { \circ }$ | $\begin{aligned} & \hline \text { A } 14 \end{aligned}$ | $\begin{aligned} & \mathrm{O} \\ & \text { A13 } \end{aligned}$ | $\stackrel{\circ}{\mathrm{O} 12}$ | $\begin{aligned} & \mathrm{O} 10 \end{aligned}$ | $\begin{aligned} & \hline \mathrm{O} \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline \mathrm{O} \\ & \mathrm{AT} \end{aligned}$ | $\begin{aligned} & \hline O \\ & A G \end{aligned}$ | $\begin{aligned} & \hline 0 \\ & A 4 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{O} 2 \\ & \mathrm{~A}^{2} \end{aligned}$ | $\begin{aligned} & \hline O_{A 1} \end{aligned}$ | $\begin{aligned} & \mathrm{O} \\ & \hline \mathrm{PS} \end{aligned}$ | $\underset{X \bar{Y}}{0}$ |
| M | $\begin{aligned} & \circ \\ & \text { D3 } \end{aligned}$ | $\begin{aligned} & \mathrm{O} \\ & \mathrm{D} 1 \end{aligned}$ | $\stackrel{\circ}{\circ}$ |  | $\stackrel{\circ}{\circ}$ | $\begin{aligned} & \circ \\ & \text { A9 } \end{aligned}$ |  |  | $\underset{\mathrm{A} 3}{\mathrm{O}}$ |  | $\stackrel{\circ}{\circ}$ | $\frac{\mathrm{O}}{\mathrm{DS}}$ | $\frac{\circ}{\mathrm{WR}}$ |
| L | $\begin{aligned} & 0 \\ & 04 \end{aligned}$ | $\begin{aligned} & \mathrm{O} \\ & \mathrm{D} 2 \end{aligned}$ |  |  |  | $\mathrm{OND}_{\mathrm{GND}}$ |  | $\stackrel{O}{\mathrm{VCc}}$ | ${ }_{\mathrm{GND}}^{\mathrm{O}}$ |  |  | $\frac{0}{\mathrm{RD}}$ | $\frac{\mathrm{O}}{8 \mathrm{~B}}$ |
| K | $\begin{aligned} & \mathrm{O} \\ & \mathrm{D} 6 \end{aligned}$ | $\begin{aligned} & 0 \\ & 05 \end{aligned}$ |  |  |  |  |  |  |  |  |  | $\frac{0}{B G}$ | $\stackrel{0}{\text { sc1 }}$ |
| J | $\begin{aligned} & \circ \\ & 0 \\ & \text { D8 } \end{aligned}$ | $\begin{aligned} & 0 \\ & 07 \end{aligned}$ | $\underset{\text { GND }}{\circ}$ |  |  |  |  |  |  |  |  | $\stackrel{\circ}{\circ}$ | $\stackrel{\circ}{\circ}$ |
| H | $\begin{aligned} & \circ \\ & 0 \\ & \text { D9 } \end{aligned}$ |  |  |  |  |  |  |  |  |  |  |  | $\stackrel{\circ}{\mathrm{SC} 2}$ |
| G | $\begin{gathered} \mathrm{D} 10 \end{gathered}$ |  | $\underset{\mathrm{vcc}}{0}$ |  | BO | OTT | OM | VIE | W |  | $\underset{\text { GND }}{\circ}$ | $\underset{\mathrm{vcc}}{\circ}$ | $\underset{\text { sck }}{\circ}$ |
| F | $\stackrel{\circ}{\circ}$ | $\underset{\text { D12 }}{0}$ | $\bigcirc$ |  |  |  |  |  |  |  |  | $\stackrel{\bigcirc}{\mathrm{Sc} 0}$ | $\begin{aligned} & \circ \\ & \text { scık } \end{aligned}$ |
| E | $\stackrel{\mathrm{D} 13}{\mathrm{O}}$ |  |  |  |  |  |  |  |  |  | $\mathrm{O}_{\mathrm{GND}}$ |  | $\underset{T \times D}{\circ}$ |
| D | $\begin{aligned} & \circ \\ & 014 \end{aligned}$ | $\begin{aligned} & \mathrm{O} \\ & \mathrm{D} 1 \end{aligned}$ | $\underset{\text { GND }}{\circ}$ |  |  |  |  |  |  |  |  | ○ | $\underset{\text { RXD }}{\circ}$ |
| C | $\begin{aligned} & \circ \\ & \text { D15 } \end{aligned}$ | $\begin{aligned} & \mathrm{O} 18 \end{aligned}$ |  |  |  | $\begin{aligned} & \mathrm{O} \mathrm{vc} \end{aligned}$ |  |  | ${ }_{\mathrm{vcc}}^{0}$ |  |  | $\underset{\mathrm{H} 2}{\mathrm{O}}$ | - |
| B | $\begin{aligned} & 0 \\ & 017 \end{aligned}$ | $\underset{\text { D20 }}{0}$ |  | $\underset{\text { D23 }}{\circ}$ | $\frac{\circ}{\frac{1 R O A}{}}$ | $\underset{\text { EXTAL }}{\circ}$ | $\stackrel{\circ}{\circ} \mathrm{OND}$ | $\underset{\text { HAO }}{\circ}$ |  | $\frac{O}{\text { HREQ }}$ | $\begin{aligned} & \mathrm{O} \\ & \mathrm{H} 7 \end{aligned}$ | $\stackrel{\circ}{\circ}$ | $\underset{\mathrm{H}}{\circ}$ |
| A | $\stackrel{\text { O }}{\text { O19 }}$ | $\underset{\text { D21 }}{0}$ | $\begin{aligned} & \circ \\ & 0 \\ & 022 \end{aligned}$ | $\stackrel{\circ}{\mathbb{R} Q B}$ | $\stackrel{\circ}{\text { RESET }}$ | $\stackrel{\circ}{\circ} \mathrm{O} \mathrm{TAL}$ | $\underset{\text { HA2 }}{\circ}$ | $\underset{\text { HA1 }}{\circ}$ | $\stackrel{\bigcirc}{\text { НАСК }}$ | $\underset{\text { HEN }}{\circ}$ | $\mathrm{O}_{\text {HRW }}$ | ; | - |
|  | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 |



Mechanical Specification Figure A-1. Pin Grid Array Mechanical Specification

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Mechanical Specification Table A-1. CQFP and PQFP Pin Out

| PIN \# | FUNCTION | PIN \# | FUNCTION | PIN \# | FUNCTION | PIN \# | FUNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 17 | NO CONNECT | 116 | NO CONNECT | 83 | NO CONNECT | 50 | NO CONNECT |
| 16 | H4 | 115 | D20 | 82 | D1 | 49 | $\overline{\text { DS }}$ |
| 15 | H5 | 114 | D19 | 81 | D0 | 48 | $X \bar{Y}$ |
| 14 | H6 | 113 | D18 | 80 | A15 | 47 | RD |
| 13 | PERIPHERAL VCC | 112 | DATA BUS GND | 79 | A14 | 46 | $\overline{\mathrm{WR}}$ |
| 12 | PERIPHERAL VCC | 111 | DATA BUS GND | 78 | NO CONNECT | 45 | $\overline{\mathrm{BR}}$ |
| 11 | H7 | 110 | NO CONNECT | 77 | A13 | 44 | NO CONNECT |
| 10 | HREQ | 109 | D17 | 76 | A12 | 43 | $\overline{\text { BG }}$ |
| 9 | HR/W | 108 | D16 | 75 | A11 | 42 | SRD |
| 8 | HEN | 107 | NO CONNECT | 74 | ADDRESS BUS GND | 41 | NO CONNECT |
| 7 | NO CONNECT | 106 | D15 | 73 | ADDRESS BUS GND | 40 | SC1 |
| 6 | HACK | 105 | D14 | 72 | NO CONNECT | 39 | STD |
| 5 | HAO | 104 | D13 | 71 | A10 | 38 | NO CONNECT |
| 4 | NO CONNECT | 103 | NO CONNECT | 70 | A9 | 37 | SC2 |
| 3 | NO CONNECT | 102 | D12 | 69 | NO CONNECT | 36 | INTERNAL LOGIC VCC |
| 2 | HA1 | 101 | DATA BUS VCC | 68 | A8 | 35 | INTERNAL LOGIC VCC |
| 1 | HA2 | 100 | DATA BUS VCC | 67 | A7 | 34 | INTERNAL LOGIC GND |
| 132 | NO CONNECT | 99 | D11 | 66 | NO CONNECT | 33 | INTERNAL LOGIC GND |
| 131 | INTERNAL LOGIC GND | 98 | NO CONNECT | 65 | A6 | 32 | SCK |
| 130 | INTERNAL LOGIC GND | 97 | D10 | 64 | ADDRESS BUS VCC | 31 | SCO |
| 129 | INTERNAL LOGIC VCC | 96 | D9 | 63 | ADDRESS BUS VCC | 30 | NO CONNECT |
| 128 | INTERNAL LOGIC VCC | 95 | NO CONNECT | 62 | NO CONNECT | 29 | SCLK |
| 127 | EXTAL | 94 | D8 | 61 | A5 | 28 | TXD |
| 126 | XTAL | 93 | D7 | 60 | A4 | 27 | RXD |
| 125 | NO CONNECT | 92 | D6 | 59 | NO CONNECT | 26 | NO CONNECT |
| 124 | RESET | 91 | DATA BUS GND | 58 | A3 | 25 | H0 |
| 123 | MODA/IRQA | 90 | DATA BUS GND | 57 | A2 | 24 | PERIPHERAL GND |
| 122 | NO CONNECT | 89 | NO CONNECT | 56 | ADDRESS BUS GND | 23 | PERIPHERAL GND |
| 121 | NMI/MODB/IRQB | 88 | D5 | 55 | ADDRESS BUS GND | 22 | H1 |
| 120 | D23 | 87 | D4 | 54 | A1 | 21 | NO CONNECT |
| 119 | D22 | 86 | D3 | 53 | A0 | 20 | H2 |
| 118 | D21 | 85 | D2 | 52 | PS | 19 | H3 |
| 117 | NO CONNECT | 84 | NO CONNECT | 51 | NO CONNECT | 18 | NO CONNECT |

Note: Do not connect to "NO CONNECT" pins.
"NO CONNECT" pins are reserved for future enhancements.

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Mechanical Specification Figure A-2. Ceramic Quad Flat Pack (Continued)

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Mechanical Specification Figure A-3. Plastic Quad Flat Pack

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Mechanical Specification Figure A-3. Plastic Quad Flat Pack (Continued)

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## APPENDIX B <br> APPLICATION EXAMPLES

The lowest cost DSP56001 based system is shown in Figure B1. It uses no run time external memory and requires only two chips, the DSP56001 and a low cost EPROM. The EPROM read access time should be less than 780 nanoseconds when the DSP56001 is operating at a clock rate of 20.5 MHz .

A system with external data RAM memory requires no glue logic to select the external EPROM from bootstrap mode. $\overline{\mathrm{PS}}$ is used to enable the EPROM and $\overline{D S}$ is used to enable the high speed data memories as shown in Figure B-2.


Note *: These diodes must be Schottky diodes.

Figure B-1. No Glue Logic, Low Cost Memory Port Bootstrap - Mode 1


Figure B-2. Port A Bootstrap with External Data RAM — Mode 1

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Figure B-3 shows the DSP56001 bootstrapping via the Host Port from an MC68000.

Systems with external program memory can load the on-chip PRAM without using the bootstrap mode. In Figure B-4, the

DSP56001 is operated in mode 2 with external program memory at location \$E000. The programmer can overlay the high speed on-chip PRAM with DSP algorithms by using the MOVEM instruction.


Figure B-4. 32K Words of External Program ROM — Mode 2

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Figure B-5 shows an alternative clock oscillator circuit used in the Graphic Equalizer application note (APR2). The $330 \Omega$ resistor provides additional current limiting in the crystal. Figure B-6 shows a circuit which waits until Vcc on the DSP is at least 4.5 V
before initiating a 3.75 ms minimum $(150,000 \mathrm{~T})$ oscillator stabilization delay required for the on-chip oscillator (only 50T is required for an external oscillator). This insures that the DSP is operational and stable before releasing the reset signal.


Figure B-5. Alternative Clock Circuit from the Graphic Equalizer (APR2)


$$
\begin{array}{ll}
\mathrm{t}_{\mathrm{DLY}}=150,000 \mathrm{~T} \text { min. } & \mathrm{V}_{\text {th }}=2.5 \mathrm{~V} \\
\mathrm{~V}_{\text {in }}=5 \mathrm{~V} & \mathrm{~V}_{\text {ol }}=0.4 \mathrm{~V} \\
\mathrm{R}=8.2 \mathrm{~K} \pm 5 \% & \mathrm{C}_{\mathrm{DLY}}=1 \mu \mathrm{f} \\
\mathrm{f}_{\mathrm{osc}}=20.5 \mathrm{MHz} & \mathrm{~T}=25 \mathrm{~ns}
\end{array}
$$

Notes: 1. $\overline{\mathrm{RQA}}$ and $\overline{\mathrm{RQBB}}$ must be hardwired.
2. MODA and MODB must be hard wired.

Figure B-6. Reset Circuit Using MC34064/MC33064

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Figure 7 illustrates how to connect a 20 ns static RAM with a 33 MHz . DSP56001. The important parameters are $\mathrm{T}_{\mathrm{DW}} \leq 10 \mathrm{~ns}$, $\mathrm{T}_{\mathrm{DOE}} \leq 10 \mathrm{~ns}$, and $\mathrm{T}_{\mathrm{AA}}=20 \mathrm{~ns}$ maximum. A 7.5 ns PLD is used to minimize decoding delays. This example maps the static RAM
into the ranges $X: \$ 1000-1 F F F$ and $Y: \$ 1000-1 F F F$. The PLD equation is:
$\overline{\text { RAM_ENABLE }}=\overline{\mathrm{PS}} \&!\overline{\mathrm{DS}} \&!\mathrm{A} 15 \&!\mathrm{A} 14 \&!\mathrm{A} 13 \&!\mathrm{A} 12$

MCM6264D
DSP56001
27 MHZ
( 8 K X 8) 20 ns


Figure B-7. 27 MHz DSP56001 with 20 ns SRAM

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Figure B-8 shows the DSP56001 connected to the bus of an IBM-PC computer. The PAL equations and other details of this circuit are available in "An ISA BUS INTERFACE FOR THE

DSP56001" which is provided on request by the Freescale DSP Marketing Department (512-891-2030).


Figure B-8. DSP56001-to-ISA Bus Interface Schematic

## APPENDIX C

MU-LAW / A-LAW EXPANSION TABLES

|  | ORG | X: \$100 |  | M_3F | DC | \$07BC00 | ; | 495 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ; |  |  |  | M_40 | DC | \$075C00 | ; | 471 |
| M_00 | DC | \$7D7C00 | ; 8031 | M_41 | DC | \$071C00 | ; | 455 |
| M_01 | DC | \$797C00 | ; 7775 | M_42 | DC | \$06DC00 | ; | 439 |
| M_02 | DC | \$757C00 | ; 7519 | M_43 | DC | \$069C00 | ; | 423 |
| M_03 | DC | \$717C00 | ; 7263 | M_44 | DC | \$065C00 | ; | 407 |
| M_04 | DC | \$6D7C00 | ; 7007 | M_45 | DC | \$061C00 | ; | 391 |
| M_05 | DC | \$697C00 | ; 6751 | M_46 | DC | \$05DC00 | ; | 375 |
| M_06 | DC | \$657C00 | ; 6495 | M_47 | DC | \$059C00 | ; | 359 |
| M_07 | DC | \$617C00 | ; 6239 | M_48 | DC | \$055C00 | ; | 343 |
| M_08 | DC | \$5D7C00 | ; 5983 | M_49 | DC | \$051C00 | ; | 327 |
| M_09 | DC | \$597C00 | ; 5727 | M_4A | DC | \$04DC00 | ; | 311 |
| M_OA | DC | \$557C00 | ; 5471 | M_4B | DC | \$049C00 | ; | 295 |
| M_0B | DC | \$517C00 | ; 5215 | M_4C | DC | \$045C00 | ; | 279 |
| M_0C | DC | \$4D7C00 | ; 4959 | M_4D | DC | \$041C00 | ; | 263 |
| M_0D | DC | \$497C00 | ; 4703 | M_4E | DC | \$03DC00 | ; | 247 |
| M_OE | DC | \$457C00 | ; 4447 | M_4F | DC | \$039C00 | ; | 231 |
| M_0F | DC | \$417C00 | ; 4191 | M_50 | DC | \$036C00 | ; | 219 |
| M_10 | DC | \$3E7C00 | ; 3999 | M_51 | DC | \$034C00 | ; | 211 |
| M_11 | DC | \$3C7C00 | ; 3871 | M_52 | DC | \$032C00 | ; | 203 |
| M_12 | DC | \$3A7C00 | ; 3743 | M_53 | DC | \$030C00 | ; | 195 |
| M_13 | DC | \$387C00 | ; 3615 | M_54 | DC | \$02EC00 | ; | 187 |
| M_14 | DC | \$367C00 | ; 3487 | M_55 | DC | \$02CC00 | ; | 179 |
| M_15 | DC | \$347C00 | ; 3359 | M_56 | DC | \$02AC00 | ; | 171 |
| M_16 | DC | \$327C00 | ; 3231 | M_57 | DC | \$028C00 | ; | 163 |
| M_17 | DC | \$307C00 | ; 3103 | M_58 | DC | \$026C00 | ; | 155 |
| M_18 | DC | \$2E7C00 | ; 2975 | M_59 | DC | \$024C00 | ; | 147 |
| M_19 | DC | \$2C7C00 | ; 2847 | M_5A | DC | \$022C00 | ; | 139 |
| M_1A | DC | \$2A7C00 | ; 2719 | M_5B | DC | \$020C00 | ; | 131 |
| M_1B | DC | \$287C00 | ; 2591 | M_5C | DC | \$01EC00 | ; | 123 |
| M_1C | DC | \$267C00 | ; 2463 | M_5D | DC | \$01CC00 | ; | 115 |
| M_1D | DC | \$247C00 | ; 2335 | M_5E | DC | \$01AC00 | ; | 107 |
| M_1E | DC | \$227C00 | ; 2207 | M_5F | DC | \$018C00 | ; | 99 |
| M_1F | DC | \$207C00 | ; 2079 | M_60 | DC | \$017400 | ; | 93 |
| M_20 | DC | \$1EFC00 | ; 1983 | M_61 | DC | \$016400 | ; | 89 |
| M_21 | DC | \$1DFC00 | ; 1919 | M_62 | DC | \$015400 | ; | 85 |
| M_22 | DC | \$1CFC00 | ; 1855 | M_63 | DC | \$014400 | ; | 81 |
| M_23 | DC | \$1BFC00 | ; 1791 | M_64 | DC | \$013400 | ; | 77 |
| M_24 | DC | \$1AFC00 | ; 1727 | M_65 | DC | \$012400 | ; | 73 |
| M_25 | DC | \$19FC00 | ; 1663 | M_66 | DC | \$011400 | ; | 69 |
| M_26 | DC | \$18FC00 | ; 1599 | M_67 | DC | \$010400 | ; | 65 |
| M_27 | DC | \$17FC00 | ; 1535 | M_68 | DC | \$00F400 | ; | 61 |
| M_28 | DC | \$16FC00 | ; 1471 | M_69 | DC | \$00E400 | ; | 57 |
| M_29 | DC | \$15FC00 | ; 1407 | M_6A | DC | \$00D400 | ; | 53 |
| M_2A | DC | \$14FC00 | ; 1343 | M_6B | DC | \$00C400 | ; | 49 |
| M_2B | DC | \$13FC00 | ; 1279 | M_6C | DC | \$00B400 | ; | 45 |
| M_2C | DC | \$12FC00 | ; 1215 | M_6D | DC | \$00A400 | ; | 41 |
| M_2D | DC | \$11FC00 | ; 1151 | M_6E | DC | \$009400 | ; | 37 |
| M_2E | DC | \$10FC00 | ; 1087 | M_6F | DC | \$008400 | ; | 33 |
| M_2F | DC | \$0FFC00 | ; 1023 | M_70 | DC | \$007800 | ; | 30 |
| M_30 | DC | \$0F3C00 | ; 975 | M_71 | DC | \$007000 | ; | 28 |
| M_31 | DC | \$0EBC00 | ; 943 | M_72 | DC | \$006800 | ; | 26 |
| M_32 | DC | \$0E3C00 | ; 911 | M_73 | DC | \$006000 | ; | 24 |
| M_33 | DC | \$0DBC00 | ; 879 | M_74 | DC | \$005800 | ; | 22 |
| M_34 | DC | \$0D3C00 | ; 847 | M_75 | DC | \$005000 | ; | 20 |
| M_35 | DC | \$0CBC00 | ; 815 | M_76 | DC | \$004800 | ; | 18 |
| M_36 | DC | \$0C3C00 | ; 783 | M_77 | DC | \$004000 | ; | 16 |
| M_37 | DC | \$0BBC00 | ; 751 | M_78 | DC | \$003800 | ; | 14 |
| M_38 | DC | \$0B3C00 | ; 719 | M_79 | DC | \$003000 | ; | 12 |
| M_39 | DC | \$0ABC00 | ; 687 | M_7A | DC | \$002800 | ; | 10 |
| M_3A | DC | \$0A3C00 | ; 655 | M_7B | DC | \$002000 | ; | 8 |
| M_3B | DC | \$09BC00 | ; 623 | M_7C | DC | \$001800 | ; | 6 |
| M_3C | DC | \$093C00 | ; 591 | M_7D | DC | \$001000 | ; | 4 |
| M_3D | DC | \$08BC00 | ; 559 | M_7E | DC | \$000800 | ; | 2 |
| M_3E | DC | \$083C00 | ; 527 | M_7F | DC | \$000000 | ; | 0 |

Figure C-1. Mu-Law/A-Law Expansion Table Contents (Sheet 1 of 2)

Freescale Semiconductor, Inc.

| A_80 | DC | \$158000 | 688 | A_C0 | DC | \$015800 | ; | 43 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A_81 | DC | \$148000 | 656 | A_C1 | DC | \$014800 | ; | 41 |
| A_82 | DC | \$178000 | 752 | A_C2 | DC | \$017800 | ; | 47 |
| A_83 | DC | \$168000 | 720 | A_C3 | DC | \$016800 | ; | 45 |
| A_84 | DC | \$118000 | 560 | A_C4 | DC | \$011800 | ; | 35 |
| A_85 | DC | \$108000 | 528 | A_C5 | DC | \$010800 | ; | 33 |
| A_86 | DC | \$138000 | 624 | A_C6 | DC | \$013800 | ; | 39 |
| A_87 | DC | \$128000 | 592 | A_C7 | DC | \$012800 | ; | 37 |
| A_88 | DC | \$1D8000 | ; 944 | A_C8 | DC | \$01D800 | ; | 59 |
| A_89 | DC | \$1C8000 | ; 912 | A_C9 | DC | \$01C800 | ; | 57 |
| A_8A | DC | \$1F8000 | 1008 | A_CA | DC | \$01F800 | ; | 63 |
| A_8B | DC | \$1E8000 | ; 976 | A_CB | DC | \$01E800 | ; | 61 |
| A_8C | DC | \$198000 | 816 | A_CC | DC | \$019800 | ; | 51 |
| A_8D | DC | \$188000 | 784 | A_CD | DC | \$018800 | ; | 49 |
| A_8E | DC | \$188000 | ; 880 | A_CE | DC | \$018800 | ; | 55 |
| A_8F | DC | \$1A8000 | 848 | A_CF | DC | \$01A800 | ; | 53 |
| A_90 | DC | \$0AC000 | 344 | A_D0 | DC | \$005800 | ; | 11 |
| A_91 | DC | \$0A4000 | ; 328 | A_D1 | DC | \$004800 | ; | 9 |
| A_92 | DC | \$0BCOOO | ; 376 | A_D2 | DC | \$007800 | ; | 15 |
| A_93 | DC | \$0B4000 | 360 | A_D3 | DC | \$006800 | ; | 13 |
| A_94 | DC | \$08c000 | ; 280 | A_D4 | DC | \$001800 | ; | 3 |
| A_95 | DC | \$084000 | ; 264 | A_D5 | DC | \$000800 | ; | 1 |
| A_96 | DC | \$09C000 | 312 | A_D6 | DC | \$003800 | ; | 7 |
| A_97 | DC | \$094000 | ; 296 | A_D7 | DC | \$002800 | ; | 5 |
| A_98 | DC | \$0EC000 | ; 472 | A_D8 | DC | \$00D800 | ; | 27 |
| A_99 | DC | \$0E4000 | ; 456 | A_D9 | DC | \$00C800 | ; | 25 |
| A_9A | DC | \$0FC000 | ; 504 | A_DA | DC | \$00F800 | ; | 31 |
| A_9B | DC | \$0F4000 | 488 | A_DB | DC | \$00E800 | ; | 29 |
| A_9C | DC | \$0ccooo | ; 408 | A_DC | DC | \$009800 | ; | 19 |
| A_9D | DC | \$0C4000 | ; 392 | A_DD | DC | \$008800 | ; | 17 |
| A_9E | DC | \$0DC000 | ; 440 | A_DE | DC | \$00B800 | ; | 23 |
| A_9F | DC | \$0D4000 | ; 424 | A_DF | DC | \$00A800 | ; | 21 |
| A_A0 | DC | \$560000 | 2752 | A_E0 | DC | \$056000 | ; | 172 |
| A_A1 | DC | \$520000 | ; 2624 | A_E1 | DC | \$052000 | ; | 164 |
| A_A2 | DC | \$5E0000 | ; 3008 | A_E2 | DC | \$05E000 | ; | 188 |
| A_A3 | DC | \$5A0000 | 2880 | A_E3 | DC | \$05A000 | ; | 180 |
| A_A4 | DC | \$460000 | ; 2240 | A_E4 | DC | \$046000 | ; | 140 |
| A_A5 | DC | \$420000 | ; 2112 | A_E5 | DC | \$042000 | ; | 132 |
| A_A6 | DC | \$4E0000 | ; 2496 | A_E6 | DC | \$04E000 | ; | 156 |
| A_A7 | DC | \$4A0000 | ; 2368 | A_E7 | DC | \$04A000 | ; | 148 |
| A_A8 | DC | \$760000 | ; 3776 | A_E8 | DC | \$076000 | ; | 236 |
| A_A9 | DC | \$720000 | ; 3648 | A_E9 | DC | \$072000 | ; | 228 |
| A_AA | DC | \$7E0000 | ; 4032 | A_EA | DC | \$07E000 | ; | 252 |
| A_AB | DC | \$7A0000 | ; 3904 | A_EB | DC | \$07A000 | ; | 244 |
| A_AC | DC | \$660000 | ; 3264 | A_EC | DC | \$066000 | ; | 204 |
| A_AD | DC | \$620000 | ; 3136 | A_ED | DC | \$062000 | ; | 196 |
| A_AE | DC | \$6E0000 | ; 3520 | A_EE | DC | \$06E000 | ; | 220 |
| A_AF | DC | \$6A0000 | ; 3392 | A_EF | DC | \$06A000 | ; | 212 |
| A_B0 | DC | \$2B0000 | ; 1376 | A_FO | DC | \$02B000 | ; | 86 |
| A_B1 | DC | \$290000 | ; 1312 | A_F1 | DC | \$029000 | ; | 82 |
| A_B2 | DC | \$2F0000 | ; 1504 | A_F2 | DC | \$02F000 | ; | 94 |
| A_B3 | DC | \$2D0000 | ; 1440 | A_F3 | DC | \$02D000 | ; | 90 |
| A_B4 | DC | \$230000 | ; 1120 | A_F4 | DC | \$023000 | ; | 70 |
| A_B5 | DC | \$210000 | ; 1056 | A_F5 | DC | \$021000 | ; | 66 |
| A_B6 | DC | \$270000 | ; 1248 | A_F6 | DC | \$027000 | ; | 78 |
| A_B7 | DC | \$250000 | ; 1184 | A_F7 | DC | \$025000 | ; | 74 |
| A_B8 | DC | \$380000 | ; 1888 | A_F8 | DC | \$038000 | ; | 118 |
| A_B9 | DC | \$390000 | ; 1824 | A_F9 | DC | \$039000 | ; | 114 |
| A_BA | DC | \$3F0000 | ; 2016 | A_FA | DC | \$03F000 | ; | 126 |
| A_BB | DC | \$3D0000 | ; 1952 | A_FB | DC | \$03D000 | ; | 122 |
| A_BC | DC | \$330000 | ; 1632 | A_FC | DC | \$033000 | ; | 102 |
| A_BD | DC | \$310000 | 1568 | A_FD | DC | \$031000 | ; | 98 |
| A_BE | DC | \$370000 | ; 1760 | A_FE | DC | \$037000 | ; | 110 |
| A_BF | DC | \$350000 | ; 1696 | A_FF | DC | \$035000 | ; | 106 |

Figure C-1. Mu-Law/A-Law Expansion Table Contents (Sheet 2 of 2)

# Freescale Semiconductor, Inc. <br> APPENDIX D <br> SINE WAVE TABLE 

This sine wave table is normally used by FFT routines which use bit reversed address pointers. This table can be used as it is for up to 512 point FFTs; however, for larger FFTs, the table must be copied to a different memory location to allow the reverse-carry addressing mode to be used (see Section 5.3.2.3 REVERSE-CARRY MODIFIER (Mn=\$0000) in the DSP56000/DSP56001 Digital Signal Processor User's Manual for additional information).

|  |  |  |  | S_38 | DC | \$7D8A5F | ; | +0.9807853103 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | ORG | Y: \$100 |  | S_39 | DC | \$7E1D94 | ; | +0.9852777123 |
| ; |  |  |  | S_3A | DC | \$7E9D56 | ; | +0.9891765118 |
| S_00 | DC | \$000000 | ; +0.0000000000 | S_3B | DC | \$7F0992 | ; | +0.9924796224 |
| S_01 | DC | \$03242B | ; +0.0245412998 | S_3C | DC | \$7F6237 | ; | +0.9951847792 |
| S_02 | DC | \$0647D9 | ; +0.0490676016 | S_3D | DC | \$7FA737 | ; | +0.9972904921 |
| S_03 | DC | \$096A90 | ; +0.0735644996 | S_3E | DC | \$7FD888 | ; | +0.9987955093 |
| S_04 | DC | \$0C8BD 3 | ; +0.0980170965 | S_3F | DC | \$7FF622 | ; | +0.9996988773 |
| S_05 | DC | \$0FAB27 | ; +0.1224106997 | S_40 | DC | \$7FFFFF | ; | +0.9999998808 |
| S_06 | DC | \$12C810 | ; +0.1467303932 | S_41 | DC | \$7FF622 | ; | +0.9996988773 |
| S_07 | DC | \$15E214 | ; +0.1709619015 | S_42 | DC | \$7FD888 | ; | +0.9987955093 |
| S_08 | DC | \$18F8B8 | ; +0.1950902939 | S_43 | DC | \$7FA737 | ; | +0.9972904921 |
| S_09 | DC | \$1C0B82 | ; +0.2191012055 | S_44 | DC | \$7F6237 | ; | +0.9951847792 |
| S_0A | DC | \$1F19F9 | ; +0.2429800928 | S_45 | DC | \$7F0992 | ; | +0.9924796224 |
| S_0B | DC | \$2223A5 | ; +0.2667128146 | S_46 | DC | \$7E9D56 | ; | +0.9891765118 |
| S_0C | DC | \$25280C | ; +0.2902846038 | S_47 | DC | \$7E1D94 | ; | +0.9852777123 |
| S_0D | DC | \$2826B9 | ; +0.3136816919 | S_48 | DC | \$7D8A5F | ; | +0.9807853103 |
| S_0E | DC | \$2B1F35 | ; +0.3368898928 | S_49 | DC | \$7CE3CF | ; | +0.9757022262 |
| S_0F | DC | \$2E110A | ; +0.3598949909 | S_4A | DC | \$7C29FC | ; | +0.9700313210 |
| S_10 | DC | \$30FBC5 | ; +0.3826833963 | S_4B | DC | \$7B5D04 | ; | +0.9637761116 |
| S_11 | DC | \$33DEF3 | ; +0.4052414000 | S_4C | DC | \$7A7D05 | ; | +0.9569402933 |
| S_12 | DC | \$36BA20 | ; +0.4275551140 | S_4D | DC | \$798A24 | ; | +0.9495282173 |
| S_13 | DC | \$398CDD | ; +0.4496113062 | S_4E | DC | \$788484 | ; | +0.9415441155 |
| S_14 | DC | \$3C56BA | ; +0.4713967144 | S_4F | DC | \$776C4F | ; | +0.9329928160 |
| S_15 | DC | \$3F174A | ; +0.4928981960 | S_50 | DC | \$7641AF | ; | +0.9238795042 |
| S_16 | DC | \$41CE1E | ; +0.5141026974 | S_51 | DC | \$7504D3 | ; | +0.9142097235 |
| S_17 | DC | \$447ACD | ; +0.5349975824 | S_52 | DC | \$73B5EC | ; | +0.9039893150 |
| S_18 | DC | \$471CED | ; +0.5555701852 | S_53 | DC | \$72552D | ; | +0.8932244182 |
| S_19 | DC | \$49B415 | ; +0.5758082271 | S_54 | DC | \$70E2CC | ; | +0.8819212914 |
| S_1A | DC | \$4C3FE0 | ; +0.5956993103 | S_55 | DC | \$6F5F03 | ; | +0.8700870275 |
| S_1B | DC | \$4EBFE9 | ; +0.6152315736 | S_56 | DC | \$6DCA0D | ; | +0.8577286005 |
| S_1C | DC | \$5133CD | ; +0.6343932748 | S_57 | DC | \$6C2429 | ; | +0.8448535204 |
| S_1D | DC | \$539B2B | ; +0.6531729102 | S_58 | DC | \$6A6D99 | ; | +0.8314697146 |
| S_1E | DC | \$55F5A5 | ; +0.6715589762 | S_59 | DC | \$68A69F | ; | +0.8175848722 |
| S_1F | DC | \$5842DD | ; +0.6895405054 | S_5A | DC | \$66CF81 | ; | +0.8032075167 |
| S_20 | DC | \$5A827A | ; +0.7071068287 | S_5B | DC | \$64E889 | ; | +0.7883464098 |
| S_21 | DC | \$5CB421 | ; +0.7242470980 | S_5C | DC | \$62F202 | ; | +0.7730104923 |
| S_22 | DC | \$5ED77D | ; +0.7409511805 | S_5D | DC | \$60EC38 | ; | +0.7572088242 |
| S_23 | DC | \$60EC38 | ; +0.7572088242 | S_5E | DC | \$5ED77D | ; | +0.7409511805 |
| S_24 | DC | \$62F202 | ; +0.7730104923 | S_5F | DC | \$5CB421 | ; | +0.7242470980 |
| S_25 | DC | \$64E889 | ; +0.7883464098 | S_60 | DC | \$5A827A | ; | +0.7071068287 |
| S_26 | DC | \$66CF 81 | ; +0.8032075167 | S_61 | DC | \$5842DD | ; | +0.6895405054 |
| S_27 | DC | \$68A69F | ; +0.8175848722 | S_62 | DC | \$55F5A5 | ; | +0.6715589762 |
| S_28 | DC | \$6A6D99 | ; +0.8314697146 | S_63 | DC | \$539B2B | ; | +0.6531729102 |
| S_29 | DC | \$6C2429 | ; +0.8448535204 | S_64 | DC | \$5133CD | , | +0.6343932748 |
| S_2A | DC | \$6DCA0D | ; +0.8577286005 | S_65 | DC | \$4EBFE9 | ; | +0.6152315736 |
| S_2B | DC | \$6F5F03 | ; +0.8700870275 | S_66 | DC | \$4C3FE0 | ; | +0.5956993103 |
| S_2C | DC | \$70E2CC | ; +0.8819212914 | S_67 | DC | \$49B415 | ; | +0.5758082271 |
| S_2D | DC | \$72552D | ; +0.8932244182 | S_68 | DC | \$471CED | ; | +0.5555701852 |
| S_2E | DC | \$73B5EC | ; +0.9039893150 | S_69 | DC | \$447ACD | ; | +0.5349975824 |
| S_2F | DC | \$7504D3 | ; +0.9142097235 | S_6A | DC | \$41CE1E | ; | +0.5141026974 |
| S_30 | DC | \$7641AF | ; +0.9238795042 | S_6B | DC | \$3F174A | ; | +0.4928981960 |
| S_31 | DC | \$776C4F | ; +0.9329928160 | S_6C | DC | \$3C56BA | ; | +0.4713967144 |
| S_32 | DC | \$788484 | ; +0.9415441155 | S_6D | DC | \$398CDD | ; | +0.4496113062 |
| S_33 | DC | \$798A24 | ; +0.9495282173 | S_6E | DC | \$36BA20 | ; | +0.4275551140 |
| S_34 | DC | \$7A7D05 | ; +0.9569402933 | S_6F | DC | \$33DEF3 | ; | +0.4052414000 |
| S_35 | DC | \$7B5D04 | ; +0.9637761116 | S_70 | DC | \$30FBC5 | ; | +0.3826833963 |
| S_36 | DC | \$7C29FC | ; +0.9700313210 | S_71 | DC | \$2E110A | ; | +0.3598949909 |
| S_37 | DC | \$7CE3CF | ; +0.9757022262 | S_72 | DC | \$2B1F35 | ; | +0.3368898928 |

Figure D-1. Sine Wave Table Contents (Sheet 1 of 3)

| S_73 | DC | \$2826B9 | ; +0.3136816919 | S_B4 | DC | \$8582FB | ; | -0.9569402933 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| S_74 | DC | \$25280C | ; +0.2902846038 | S_B5 | DC | \$84A2FC | ; | -0.9637761116 |
| S_75 | DC | \$2223A5 | +0.2667128146 | S_B6 | DC | \$83D604 | ; | -0.9700313210 |
| S_76 | DC | \$1F19F9 | ; +0.2429800928 | S_B7 | DC | \$831C31 | ; | -0.9757022262 |
| S_77 | DC | \$1C0B82 | ; +0.2191012055 | S_B8 | DC | \$8275A1 | ; | -0.9807853103 |
| S_78 | DC | \$18F8B8 | ; +0.1950902939 | S_B9 | DC | \$81E26C | ; | -0.9852777123 |
| S_79 | DC | \$15E214 | ; +0.1709619015 | S_BA | DC | \$8162AA | ; | -0.9891765118 |
| S_7A | DC | \$12C810 | ; +0.1467303932 | S_BB | DC | \$80F66E | ; | -0.9924796224 |
| S_7B | DC | \$0FAB27 | ; +0.1224106997 | S_BC | DC | \$809DC9 | ; | -0.9951847792 |
| S_7C | DC | \$0C8BD3 | ; +0.0980170965 | S_BD | DC | \$8058C9 | ; | -0.9972904921 |
| S_7D | DC | \$096A90 | ; +0.0735644996 | S_BE | DC | \$802778 | ; | -0.9987955093 |
| S_7E | DC | \$0647D9 | ; +0.0490676016 | S_BF | DC | \$8009DE | ; | -0.9996988773 |
| S_7F | DC | \$03242B | ; +0.0245412998 | S_C0 | DC | \$800000 | ; | -1.0000000000 |
| S_80 | DC | \$000000 | ; +0.0000000000 | S_C1 | DC | \$8009DE | ; | -0.9996988773 |
| S_81 | DC | \$FCDBD5 | ; -0.0245412998 | S_C2 | DC | \$802778 | ; | -0.9987955093 |
| S_82 | DC | \$F9B827 | ; -0.0490676016 | S_C3 | DC | \$8058C9 | ; | -0.9972904921 |
| S_83 | DC | \$F69570 | ; -0.0735644996 | S_C4 | DC | \$809DC9 | ; | -0.9951847792 |
| S_84 | DC | \$F3742D | ; -0.0980170965 | S_C5 | DC | \$80F66E | ; | -0.9924796224 |
| S_85 | DC | \$F054D9 | ; -0.1224106997 | S_C6 | DC | \$8162AA | ; | -0.9891765118 |
| S_86 | DC | \$ED37F0 | ; -0.1467303932 | S_C7 | DC | \$81E26C | ; | -0.9852777123 |
| S_87 | DC | \$EA1DEC | ; -0.1709619015 | S_C8 | DC | \$8275A1 | ; | -0.9807853103 |
| S_88 | DC | \$E70748 | ; -0.1950902939 | S_C9 | DC | \$831C31 | ; | -0.9757022262 |
| S_89 | DC | \$E3F47E | ; -0.2191012055 | S_CA | DC | \$83D604 | ; | -0.9700313210 |
| S_8A | DC | \$E0E607 | ; -0.2429800928 | S_CB | DC | \$84A2FC | ; | -0.9637761116 |
| S_8B | DC | \$DDDC5B | ; -0.2667128146 | S_CC | DC | \$8582FB | ; | -0.9569402933 |
| S_8C | DC | \$DAD7F4 | ; -0.2902846038 | S_CD | DC | \$8675DC | ; | -0.9495282173 |
| S_8D | DC | \$D7D947 | ; -0.3136816919 | S_CE | DC | \$877B7C | ; | -0.9415441155 |
| S_8E | DC | \$D4E0CB | ; -0.3368898928 | S_CF | DC | \$8893B1 | ; | -0.9329928160 |
| S_8F | DC | \$D1EEF6 | ; -0.3598949909 | S_D0 | DC | \$89BE51 | ; | -0.9238795042 |
| S_90 | DC | \$CF043B | ; -0.3826833963 | S_D1 | DC | \$8AFB2D | ; | -0.9142097235 |
| S_91 | DC | \$CC210D | ; -0.4052414000 | S_D2 | DC | \$8C4A14 | ; | -0.9039893150 |
| S_92 | DC | \$C945E0 | ; -0.4275551140 | S_D3 | DC | \$8DAAD3 | ; | -0.8932244182 |
| S_93 | DC | \$C67323 | ; -0.4496113062 | S_D4 | DC | \$8F1D34 | ; | -0.8819212914 |
| S_94 | DC | \$C3A946 | ; -0.4713967144 | S_D5 | DC | \$90A0FD | ; | -0.8700870275 |
| S_95 | DC | \$C0E8B6 | ; -0.4928981960 | S_D6 | DC | \$9235F3 | ; | -0.8577286005 |
| S_96 | DC | \$BE31E2 | ; -0.5141026974 | S_D7 | DC | \$93DBD7 | ; | -0.8448535204 |
| S_97 | DC | \$BB8533 | ; -0.5349975824 | S_D8 | DC | \$959267 | ; | -0.8314697146 |
| S_98 | DC | \$B8E313 | ; -0.5555701852 | S_D9 | DC | \$975961 | ; | -0.8175848722 |
| S_99 | DC | \$B64BEB | ; -0.5758082271 | S_DA | DC | \$99307F | ; | -0.8032075167 |
| S_9A | DC | \$B3C020 | ; -0.5956993103 | S_DB | DC | \$9B1777 | ; | -0.7883464098 |
| S_9B | DC | \$B14017 | ; -0.6152315736 | S_DC | DC | \$9D0DFE | ; | -0.7730104923 |
| S_9C | DC | \$AECC33 | ; -0.6343932748 | S_DD | DC | \$9F13C8 | ; | -0.7572088242 |
| S_9D | DC | \$AC64D5 | ; -0.6531729102 | S_DE | DC | \$A12883 | ; | -0.7409511805 |
| S_9E | DC | \$AA0A5B | ; -0.6715589762 | S_DF | DC | \$A34BDF | ; | -0.7242470980 |
| S_9F | DC | \$A7BD23 | ; -0.6895405054 | S_E0 | DC | \$A57D86 | ; | -0.7071068287 |
| S_A0 | DC | \$A57D86 | ; -0.7071068287 | S_E1 | DC | \$A7BD23 | ; | -0.6895405054 |
| S_A1 | DC | \$A34BDF | ; -0.7242470980 | S_E2 | DC | \$AA0A5B | ; | -0.6715589762 |
| S_A2 | DC | \$A12883 | ; -0.7409511805 | S_E3 | DC | \$AC64D5 | ; | -0.6531729102 |
| S_A3 | DC | \$9F13C8 | ; -0.7572088242 | S_E4 | DC | \$AECC33 | ; | -0.6343932748 |
| S_A4 | DC | \$9D0DFE | ; -0.7730104923 | S_E5 | DC | \$B14017 | ; | -0.6152315736 |
| S_A5 | DC | \$9B1777 | ; -0.7883464098 | S_E6 | DC | \$B3C020 | ; | -0.5956993103 |
| S_A6 | DC | \$99307F | ; -0.8032075167 | S_E7 | DC | \$B64BEB | ; | -0.5758082271 |
| S_A7 | DC | \$975961 | ; -0.8175848722 | S_E8 | DC | \$B8E313 | ; | -0.5555701852 |
| S_A8 | DC | \$959267 | ; -0.8314697146 | S_E9 | DC | \$BB8533 | ; | -0.5349975824 |
| S_A9 | DC | \$93DBD7 | ; -0.8448535204 | S_EA | DC | \$BE31E2 | ; | -0.5141026974 |
| S_AA | DC | \$9235F3 | ; -0.8577286005 | S_EB | DC | \$C0E8B6 | ; | -0.4928981960 |
| S_AB | DC | \$90A0FD | ; -0.8700870275 | S_EC | DC | \$C3A946 | ; | -0.4713967144 |
| S_AC | DC | \$8F1D34 | ; -0.8819212914 | S_ED | DC | \$C67323 | ; | -0.4496113062 |
| S_AD | DC | \$8DAAD3 | ; -0.8932244182 | S_EE | DC | \$C945E0 | ; | -0.4275551140 |
| S_AE | DC | \$8C4A14 | ; -0.9039893150 | S_EF | DC | \$CC210D | ; | -0.4052414000 |
| S_AF | DC | \$8AFB2D | ; -0.9142097235 | S_F0 | DC | \$CFO43B | ; | -0.3826833963 |
| S_B0 | DC | \$89be51 | ; -0.9238795042 | S_F1 | DC | \$D1EEF6 | ; | -0.3598949909 |
| S_B1 | DC | \$8893B1 | ; -0.9329928160 | S_F2 | DC | \$D4E0CB | ; | -0.3368898928 |
| S_B2 | DC | \$877B7C | ; -0.9415441155 | S_F3 | DC | \$D7D947 | ; | -0.3136816919 |
| S_B3 | DC | \$8675DC | ; -0.9495282173 | S_F4 | DC | \$DAD7F4 | ; | -0.2902846038 |

Figure D-1. Sine Wave Table Contents (Sheet 2 of 3)

## Freescale Semiconductor, Inc.

| S_F5 | DC | \$DDDC5B | $;-0.2667128146$ | S_FB | DC | \$F054D9 | $;-0.1224106997$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| S_F6 | DC | \$E0E607 | $;-0.2429800928$ | S_FC | DC | \$F3742D | $;-0.0980170965$ |
| S_F7 | DC | \$E3F47E | $;-0.2191012055$ | S_FD | DC | \$F69570 | $;-0.0735644996$ |
| S_F8 | DC | \$E70748 | $;-0.1950902939$ | S_FE | DC | \$F9B827 | $;-0.0490676016$ |
| S_F9 | DC | \$EA1DEC | $;-0.1709619015$ | S_FF | DC | \$FCDBD5 | $;-0.0245412998$ |
| S_FA | DC | \$ED37F0 | $;-0.1467303932$ |  |  |  |  |

Figure D-1. Sine Wave Table Contents (Sheet 3 of 3)

# Freescale Semiconductor, Inc. <br> APPENDIX E <br> BOOTSTRAP MODE - OPERATING MODE 1 

The bootstrap feature of the DSP56001 consists of four special on-chip modules: the 512 words of PRAM, a 32-word bootstrap ROM, the bootstrap control logic, and the bootstrap firmware program.

## BOOTSTRAP ROM

This 32-word on-chip ROM has been factory programmed to perform the actual bootstrap operation from the memory expansion port (Port A) or from the Host Interface. You have no access to the bootstrap ROM other than through the bootstrap process. Control logic will disable the bootstrap ROM during normal operations.

## BOOTSTRAP CONTROL LOGIC

The bootstrap mode control logic is activated when the DSP56001 is placed in Operating Mode 1. The control logic maps the bootstrap ROM into program memory space as long as the DSP56001 remains in Operating Mode 1. The bootstrap firmware changes operating modes when the bootstrap load is completed. When the DSP56001 exits the reset state in Mode 1, the following actions occur.

1. The control logic maps the bootstrap ROM into the internal DSP program memory space starting at location $\$ 0000$. This P: space is read-only.
2. The control logic forces the entire $P$ : space to be writeonly memory during the bootstrap loading process. Attempts to read from this space will result in fetches from the read-only bootstrap ROM.
3. Program execution begins at location $\$ 0000$ in the bootstrap ROM. The bootstrap ROM program is able to perform the PRAM load through either the memory expansion port from a byte-wide external memory, or through the Host Interface.
4. The bootstrap ROM program executes the following sequence to end the bootstrap operation and begin your program execution.
A. Enter Operating Mode 2 by writing to the OMR. This action will be timed to remove the bootstrap ROM from the program memory map and re-enable read/write access to the PRAM.
B. The change to Mode 2 is timed exactly to allow the boot program to execute a single cycle instruction then a JMP \#00 and begin execution of the program at location $\$ 0000$.
You may also select the bootstrap mode by writing Operating Mode 1 into the OMR. This initiates a timed operation to map the bootstrap ROM into the program address space after a delay to allow execution of a single cycle instruction and then a JMP \#<00 (e.g., see Bootstrap code for DSP56001) to begin the bootstrap process as described above in steps 1-4. This technique allows the DSP56001 user to reboot the system (with a different program if desired).

## BOOTSTRAP FIRMWARE PROGRAM

Bootstrap ROM contains the bootstrap firmware program that performs initial loading of the DSP56001 PRAM. The program is written in DSP56000/DSP56001 assembly language. It contains two separate methods of initializing the PRAM: loading from a byte-wide memory starting at location P:\$C000 or loading
through the Host Interface. The particular method used is selected by the level of program memory location \$C000, bit 23. If location P: $\$ C 000$, bit 23 is read as a one, the external bus version of the bootstrap program will be selected. Typically, a byte wide EPROM will be connected to the DSP56001 Address and Data Bus as shown in Figure B-1 of the applications examples given in APPENDIX B APPLICATIONS EXAMPLES. The data contents of the EPROM must be organized as shown below.

| Address of External | Contents Loaded |
| :---: | :---: |
| Byte Wide P Memory P:\$C000 | to Internal PRAM at P:\$0000 low byte |
| P:\$C001 | $\mathrm{P}: \$ 0000$ mid byte |
| P:\$C002 | $\mathrm{P}: \$ 0000$ high byte |
| - | - |
| - | - |
| - | - |
| P:\$C5FD | P:\$01FF low byte |
| P:\$C5FE | P :\$01FF mid byte |
| P:\$C5FF | P:\$01FF high byte |

If location P:\$C000, bit 23 is read as a zero, the Host Interface version of the bootstrap program will be selected. Typically a host microprocessor will be connected to the DSP56001 Host Interface. The host microprocessor must write the Host Interface registers THX, TXM, and then TSL with the desired contents of PRAM from location P:\$0000 up to P:\$01FF. If less than 512 words are to be loaded, the host programmer can exit the bootstrap program and force the DSP56001 to begin executing at location P: $\$ 0000$ by setting HF0=1 in the Host Interface during the bootstrap load. In most systems, the DSP56001 responds so fast that handshaking between the DSP56001 and the host is not necessary.
The bootstrap program is shown in flowchart form in Figure E-1 and in assembler listing format in Figure E-2.

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Figure E-1. Bootstrap Program Flowchart

## Freescale Semiconductor, Inc.

```
    PAGE 132,50,0,10
    ; BOOTSTRAP SOURCE CODE FOR DSP56001 - (C) Copyright 1986 Motorola Inc.
; Host algorithm / AND / external bus method
; This is the Bootstrap source code contained in the DSP56001 32 word boot ROM.
; This program can load the internal program memory from one of two external sources.
; The program reads P:$C000 bit 23 to decide which external source to access. If
; P:$C000 bit 23 = 0 then it loads internal PRAM from H0-H7, using the Host Interface
; logic. If P:$C000 bit 23=1 then it loads from 1,536 consecutive byte-wide P:
; memory locations (starting at P:$C000).
0000C000
BOOT EQU $C000 ; The location in P: memory
                                    ; where the external byte-wide
                                    ; EPROM is expected to be mapped.
                    ORG PL:$0 ; Bootstrap code starts at P:$0
P:0000 62F400
00FFE9
P:0002 61F400
00C000
P:0004 300000
MOVE
    #0,R0
    ; external bootstrap byte-wide ROM.
                                    ; R0 = starting P: address of
                                    ; internal memory where program
                                    ; will begin loading.
            MOVE P:(R1),AI ; Get the data at P:$C000
            ROL A
JCC <INLOOP
; Shift bit 23 into the Carry flag
P:0005 07E18C
P:0007 0E0009
\begin{tabular}{|c|c|c|c|}
\hline ORG & PL:\$0 & & ; Bootstrap code starts at P:\$0 \\
\hline MOVE & & \#\$FFE9,R2 & ; R2 = address of the Host \\
\hline MOVE & & \#BOOT,R1 & \begin{tabular}{l}
; Interface status register. \\
; R1 = starting P: address of
\end{tabular} \\
\hline & & & ; external bootstrap byte-wide ROM. \\
\hline MOVE & & \#0,R0 & ; \(\mathrm{R} 0=\) starting P : address of ; internal memory where program ; will begin loading. \\
\hline MOVE & & \(\mathrm{P}:(\mathrm{R} 1), \mathrm{Al}\) & ; Get the data at P:\$C000 \\
\hline ROL & A & & ; Shift bit 23 into the Carry flag \\
\hline JCC & <INLOOP & & ; Perform load from Host Interface ; if carry is zero. \\
\hline
\end{tabular}
; IMPORTANT NOTE: This routine assumes that the \(L\) bit has been cleared before entering
; this program and that M0 and M1 have been preloaded with \$FFFF (linear addressing).
; This would be the case after a reset. If this program is entered by changing the OMR
```

Figure E-2. Assembler Listing for Bootstrap Program (Sheet 1 of 3)

## Freescale Semiconductor, Inc.

```
; to bootstrap operating mode, make certain that the L bit is cleared and registers M0
; and M1have been set to $FFFF. Also, make sure the BCR is set to $xxFx since
; EPROMS are slow and BCR is set to $FFFF after a reset. If the L bit was set before
; changing modes, the program will load from external program memory.
\begin{tabular}{ll} 
P:0008 ORI \(\quad\) ORI & ; Set the L bit to indicate \\
& \(;\) that the bootstrap program \\
& \(;\) is being loaded from the \\
& \(;\) external \(P:\) space.
\end{tabular}
; The first routine will load 1,536 bytes from the external P: memory space beginning ; at P:\$C000 (bits 7-0). These will be packed into 512 24-bit words and stored in ; contiguous internal PRAM memory locations starting at P:\$0.
; The shifter moves the 8-bit input data from register A2 into register A1 eight bits ; at a time. After assembling one 24-bit word (this takes three loops) it stores the ; result in internal PRAM and continues until internal PRAM is filled. Note that the ; first routine loads data starting with the least significant byte of \(P: \$ 0\) first.
; The second routine loads the internal PRAM using the Host Interface logic.
; If the host only wants to load a portion of the PRAM, the Host Interface bootstrap
; load program can be aborted and execution of the loaded program started, by setting ; the Host Flag (HF0) = 1 at any time during the load from the Host Processor.
\begin{tabular}{clll} 
P:0009 & 060082 \\
00001 B
\end{tabular} INLOOP D0 \(\quad\); Load 512 instruction words.
; This is the context switch
P:000B 0E6012 JLC < Load from the Host Interface ; if the Limit flag is clear.
; This is the first routine. It loads from external P: memory.
P:000C 060380
DO
\#3, _LOOP2
; Each instruction has 3 bytes. 000010
```

Figure E-2. Assembler Listing for Bootstrap Program (Sheet 2 of 3)

## Freescale Semiconductor, Inc.

| 69 | P:000E | 07D98A |  | MOVE | $\mathrm{P}:(\mathrm{R} 1)+, \mathrm{A} 2$ | ; Get the 8 LSB from external |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 70 |  |  |  |  |  | ; P: memory. |
| 71 | P:000F | 0608A0 |  | REP | \#8 | ; Shift 8 bit data into A1 |
| 72 | P:0010 | 200022 |  | ASR | A |  |
| 73 |  |  | _LOOP2 |  |  | ; Get another byte |
| 74 | P:0011 | 0C001B |  | JMP | < STORE | ; then put the word in PRAM. |
| 75 |  |  |  |  |  |  |
| 76 |  |  | ; This is the second routine. It loads from the Host Interface pins. |  |  |  |
| 77 |  |  |  |  |  |  |
| 78 | P:0012 | 0AA020 | _HOSTLD | BSET | \#0,X:\$FFE0 | ; Configure Port B as Host Interface |
| 79 | P:0013 | 0AA983 | _LBLA | JCLR | \#3,X:\$FFE9, _LBLB | ; If $\mathrm{HFO}=1$, stop loading data. |
|  |  | 000017 |  |  |  |  |
| 80 | P:0015 | 00008C |  | ENDDO |  | ; Must terminate the DO loop |
| 81 | P:0016 | 0C001C |  | JMP | <_BOOTEND |  |
| 82 |  |  |  |  |  |  |
| 83 | P:0017 | 0 A6280 | _LBLB | JCLR | \#0,X:(R2), _LBLA | ; Wait for HRDF to go high |
|  |  | 000013 |  |  |  |  |
| 84 |  |  |  |  |  | ; (meaning 24-bit data is present) |
| 85 | P:0019 | 54F000 |  | MOVE | X:\$FFEB,A1 | ; Put 24-bit host data in A1 |
|  |  | 00FFEB |  |  |  |  |
| 86 |  |  |  |  |  |  |
| 87 | P:001B | 07588C | _STORE | MOVE | A1,P:(R0)+ | ; Store 24-bit result in PRAM. |
| 88 |  |  |  |  |  |  |
| 89 |  |  | _LOOP1 |  |  | ; and return for another 24-bit word |
| 90 退 90 |  |  |  |  |  |  |
| 91 |  |  | ; This is the exit handler that returns execution to normal expanded mode |  |  |  |
| 92 |  |  | ; and jumps to the RESET location. |  |  |  |
| 93 ( 93 |  |  |  |  |  |  |
| 94 |  |  | P:001C | 0502BA | _BOOTEND | MOVEC | \#2,0MR | ; Set the operating mode to 2 <br> ; (and trigger an exit from ; bootstrap mode). |
| 95 |  |  |  |  |  |  |  |  |
| 96 |  |  |  |  |  |  |  |  |
| 97 | P:001D | 0000B9 |  | ANDI | \#\$0,CCR | ; Clear SR as if RESET and <br> ; introduce delay needed for <br> ; Op. Mode change. <br> ; Start fetching from PRAM P:\$0000 |  |  |
| 98 |  |  |  |  |  |  |  |  |
| 99 |  |  |  |  |  |  |  |  |
| $\begin{aligned} & 100 \\ & 101 \end{aligned}$ | P:001E | 0 COOOO |  | JMP | <\$0 |  |  |  |
|  |  |  |  |  |  |  |  |  |
| Freescale DSP56000 Macro Cross Assembler Version 2.00 87-08-23 09:57:46 bootcode.asm Page 4 |  |  |  |  |  |  |  |  |
| 0 Errors |  |  |  |  |  |  |  |  |
| 0 W | arnings |  |  |  |  |  |  |  |

Figure E-2. Assembler Listing for Bootstrap Program (Sheet 3 of 3)

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